

BREMEN-M 15"/17"

CPU : Intel Arrandale
Chip Set : Intel Ixex Peak(HM55)
GFX : N11P/ M-GE1(40nm)
Remarks : Calpella Platform

Model Name : BREMEN-M
PBA Name : MAIN
PCB Code : BA41-01174A
Dev. Step : PR
Revision : 1.0
T.R. Date : 2009.11.12

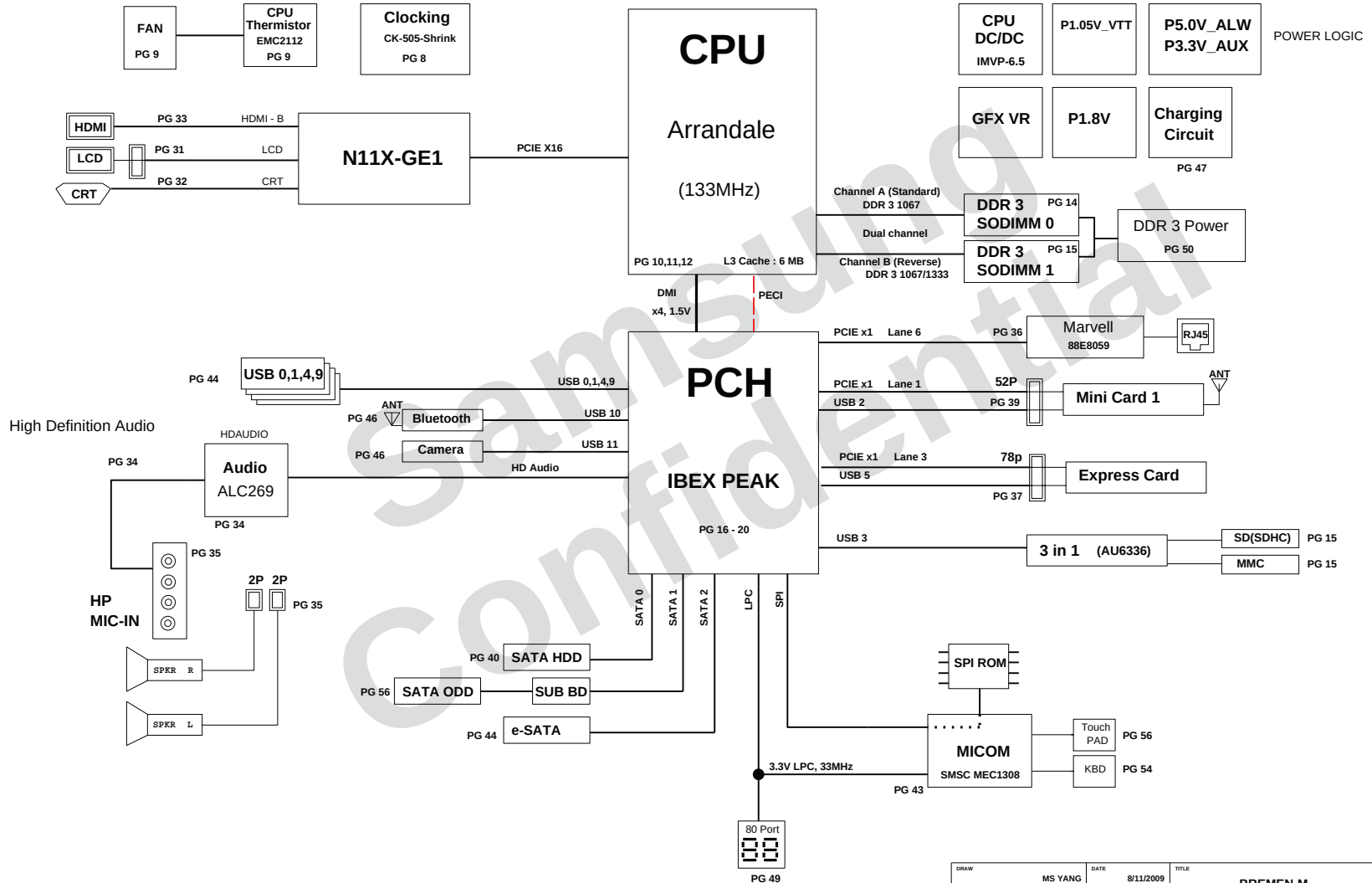
Design	CHECK	APPROVAL

Owner : SEC Mobile R & D Signature : X

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DRAW	MS YANG	DATE	8/11/2009	TITLE	BREMEN-M	SAMSUNG
CHECK	SE LEE	DEV. STEP	PV	MAIN	COVER	ELECTRONICS
APPROVAL	MK KIM	REV	REV 0.9			PART NO.
MODULE CODE		LAST EDIT				BA41-01174A
				October 20, 2009 21:30:55 PM	PAGE	1 OF 56

BLOCK DIAGRAM

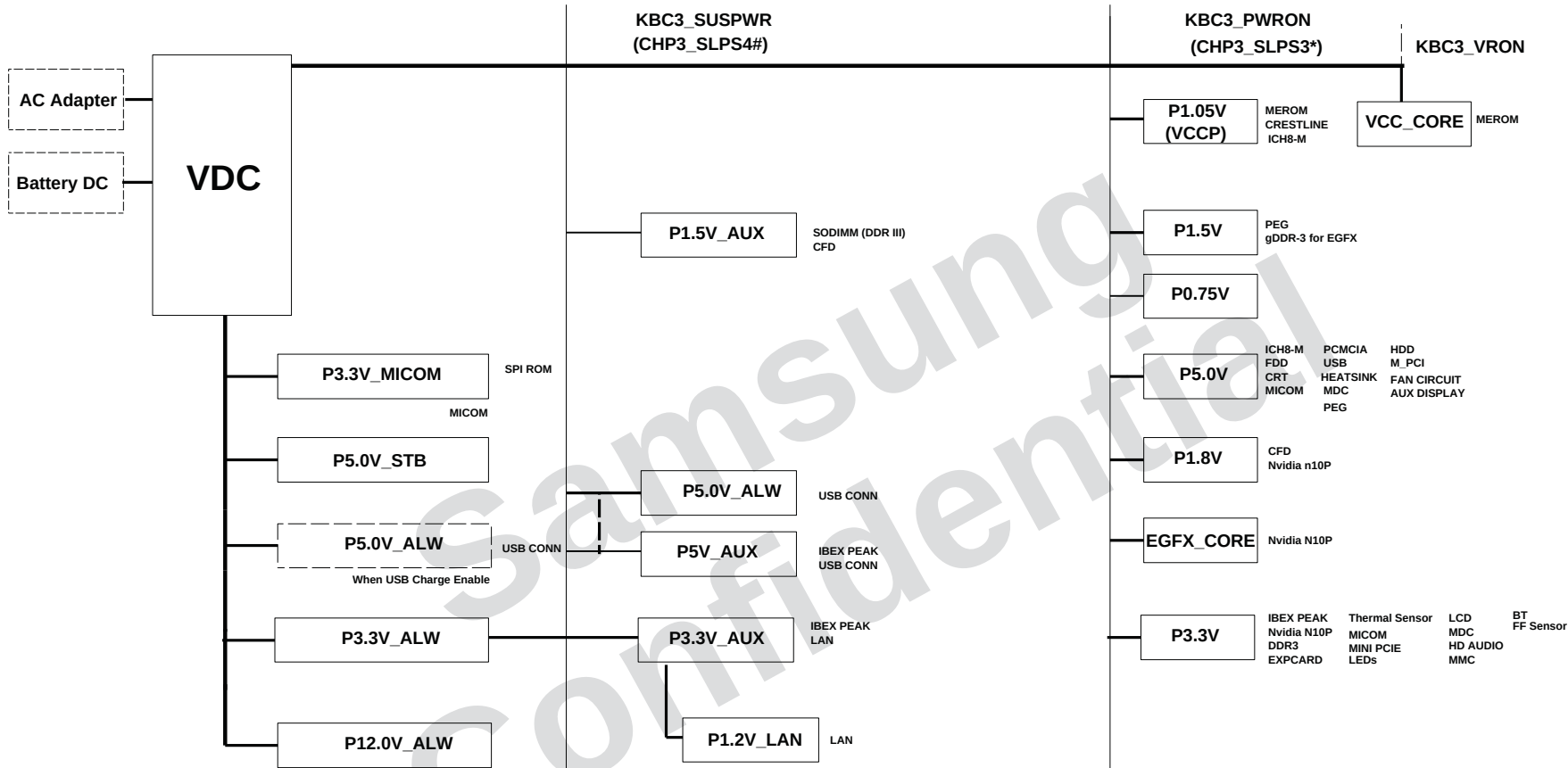


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CHECK	SE LEE	DEV. STEP	PV			
APPROVAL	MK KIM	REV	REV 0.9		BLOCK DIAGRAM	PART NO. BA41-01174A
MODULE CODE	undefined	LAST EDIT				

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POWER DIAGRAM

Rev 0.1



Power On/Off Table by S-state

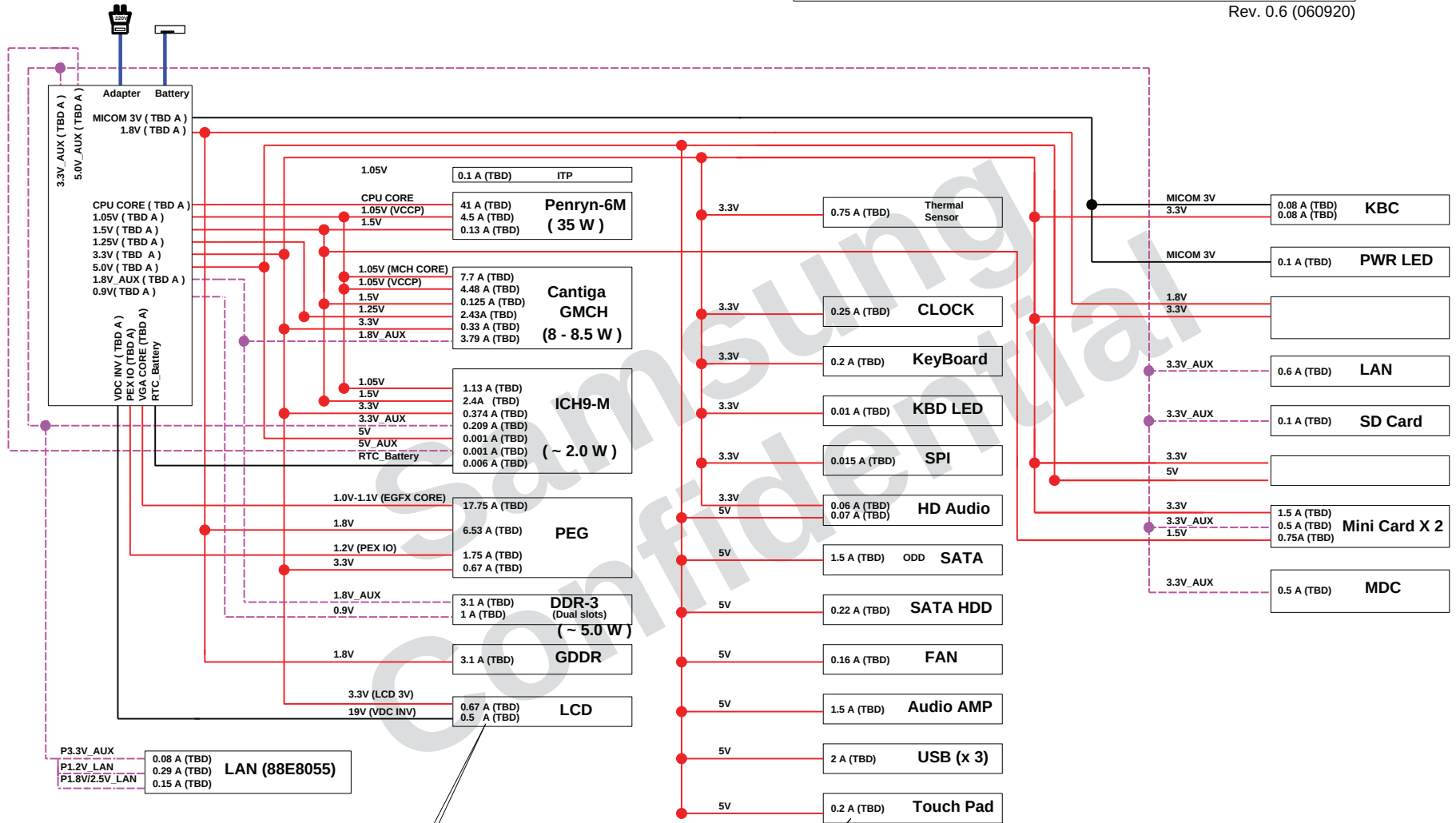
Rail State	S0	S3	S4	S5
+V*A(LWS) +V*LAN	ON	ON	ON	ON
+1.8V_AUX +0.9V	ON	ON	—	—
+V*AUX	ON	ON	—	—
+V	ON	—	—	—
+V* (CORE)	ON	—	—	—



DRAW	MS YANG	DATE	8/11/2009	TITLE	BREMEN-M MAIN	SAMSUNG ELECTRONICS
CHECK	SE LEE	DEV. STEP	PV			
APPROVAL	MK KIM	REV	REV 0.9		POWER DIAGRAM	PART NO. BA41-01174A
MODULE CODE	undefined	LAST EDIT		October 20, 2009 21:30:55 PM	PAGE	3 OF 56

POWER RAILS ANALYSIS

Rev. 0.6 (060920)



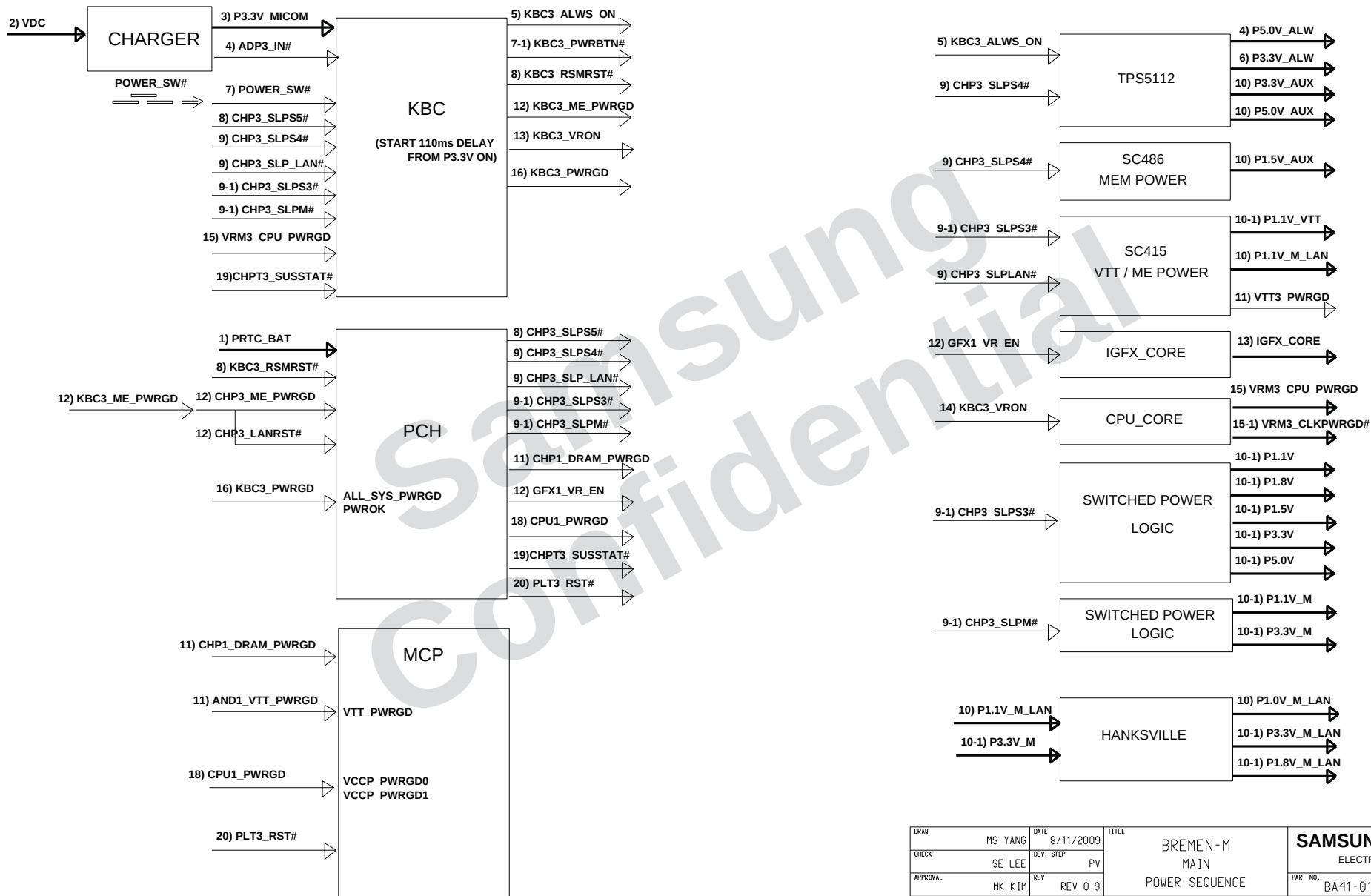
Value by Datasheet/Application notes (Value by measurement)

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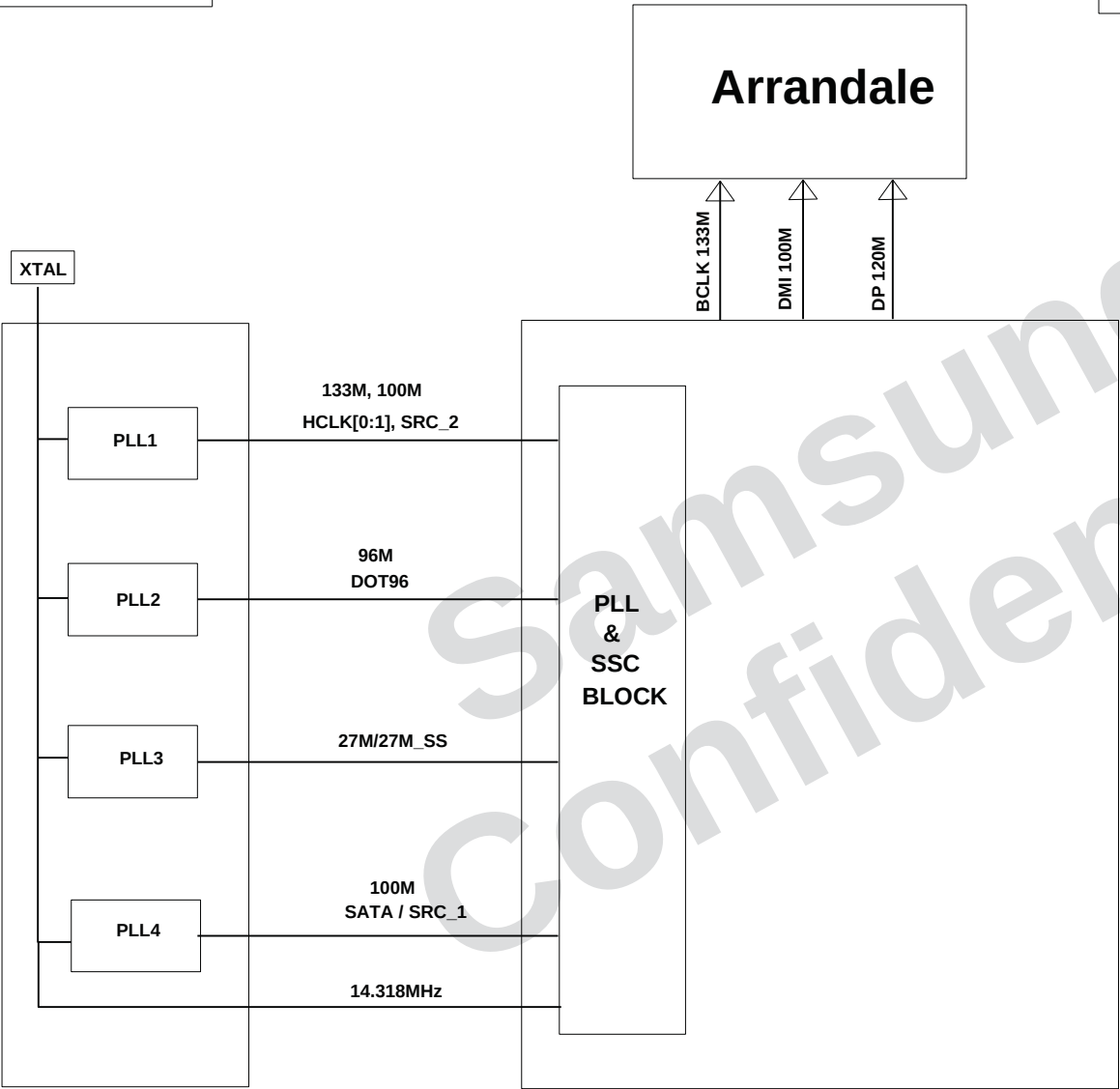
PRELIMINARY

POWER SEQUENCE

Rev. 0.5



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APPROVAL	MK KIM	REV	REV 0.9			
MODULE CODE	undefined	LAST EDIT	October 20, 2009 21:30:55 PM	PAGE	5	OF 56

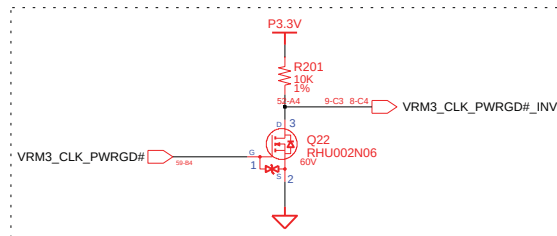
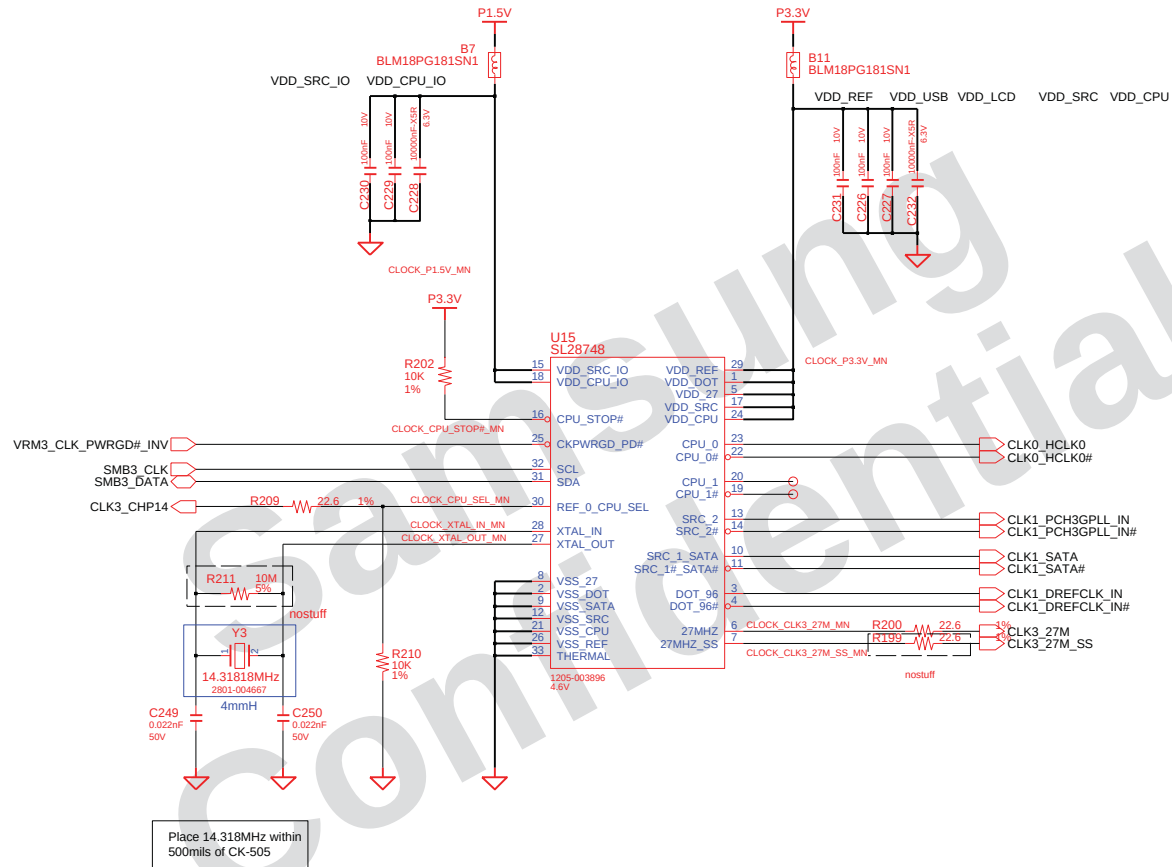


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CHECK	SE LEE	DEV. STEP	PV				
APPROVAL	MK KIM	REV	REV 0.9				
MODULE CODE	undefined	LAST EDIT		October 20, 2009 21:30:55 PM		PAGE	6 OF 56

CK505M SHRINK VERSION

CPU_MODE SEL

Pin 30	CPU_0	CPU_1
CPU_SEL = 0	133MHz	133MHz

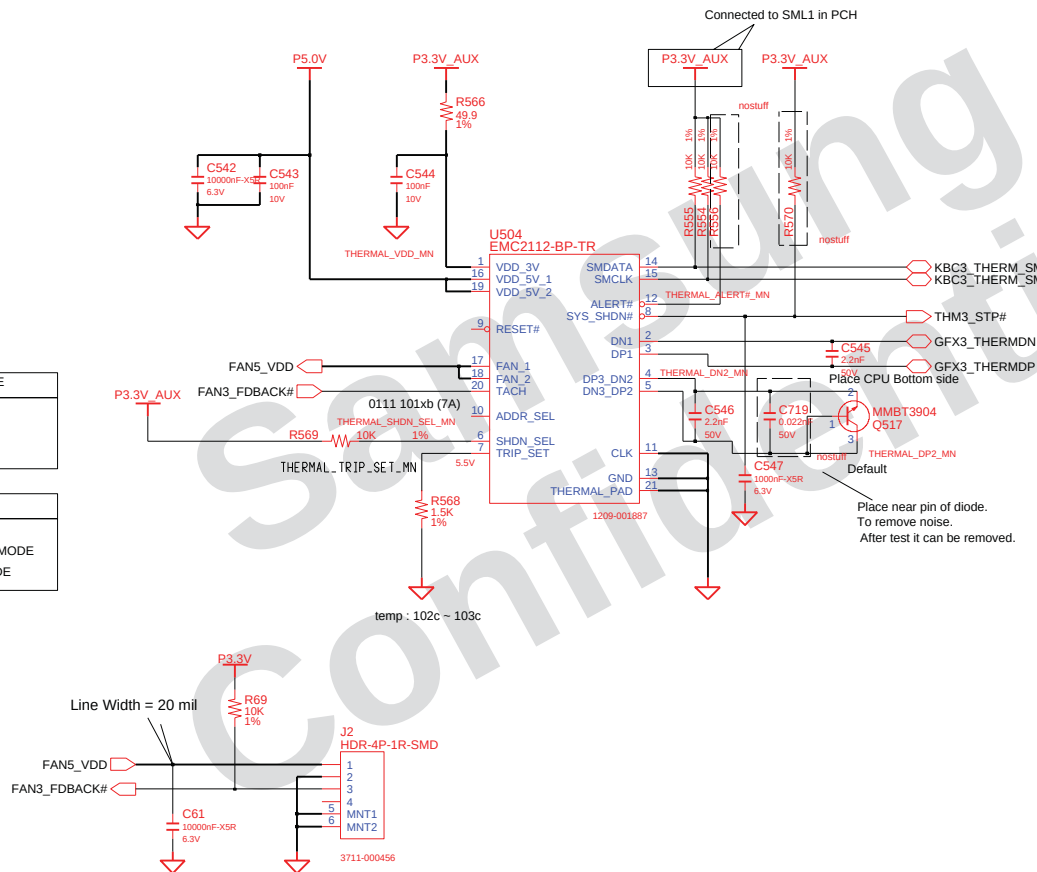


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CHECK	SE LEE	DEV. STEP	PV			
APPROVAL	MK KIM	REV	REV 0.9			
MODULE CODE		LAST EDIT				
October 20, 2009 21:30:55 PM				PAGE	7	OF 56

THERMAL SENSOR & FAN CONTROL

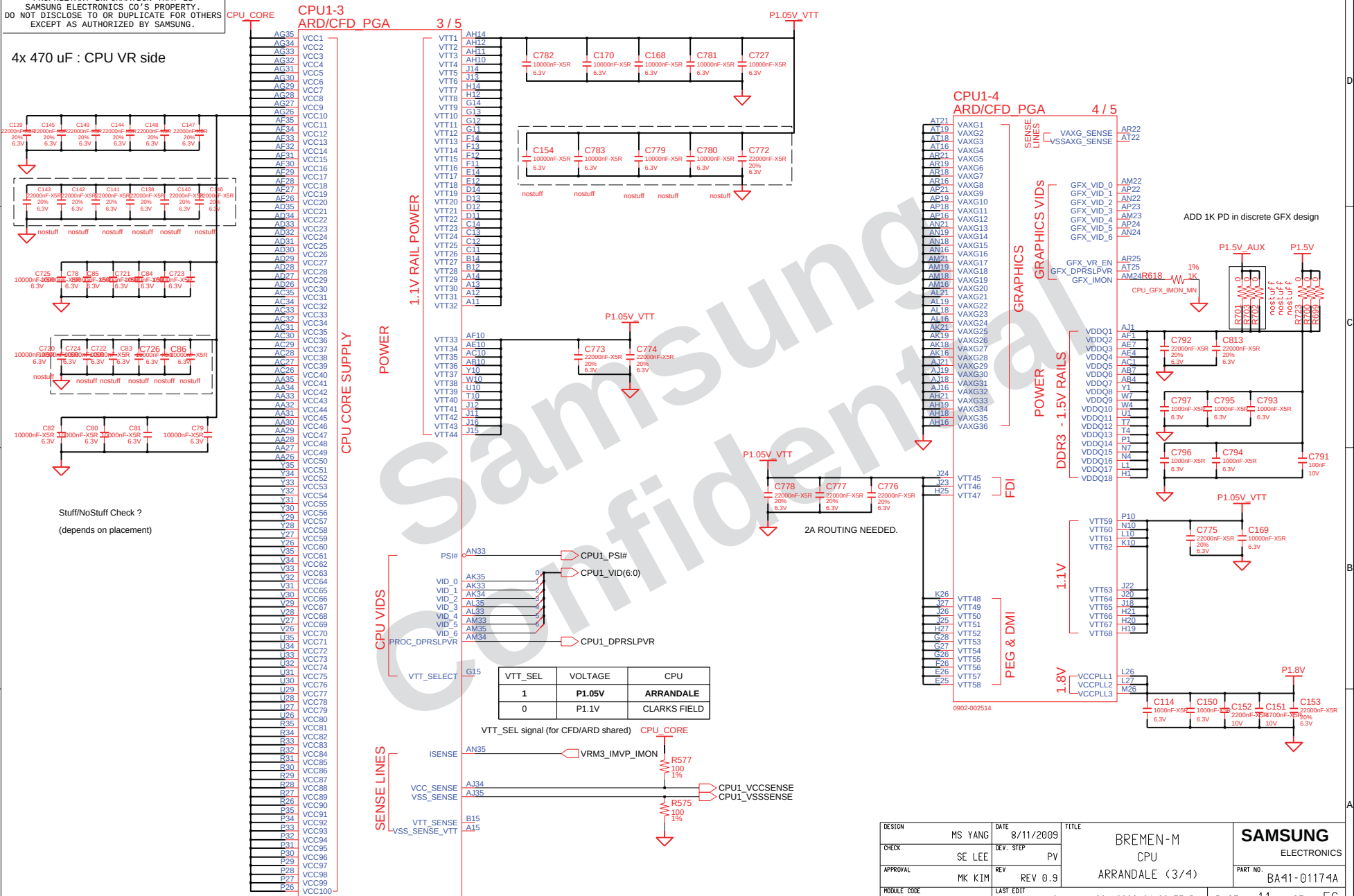
ADDRESSSEL MODE	
0	0101 111xb
✓ HIGH Z	0111 101xb (7A)
1	0101 110xb

SHDNSEL MODE	
0	INTEL TR MODE
✓ HIGH Z	AMD CPU/DIODE MODE
1	EXT.DIODE 2 MODE





ALL VTT DECAP IS SHARED



CPU1-5
ARD/CFD_PG45 / 5

AT20	VSS1	AE34
AR31	VSS2	AE33
AR31	VSS3	AE32
AR28	VSS4	AE31
AR26	VSS5	AE30
AR24	VSS6	AE29
AR23	VSS7	AE28
AR20	VSS8	AE27
AR17	VSS9	AE26
AR15	VSS10	AE25
AR12	VSS11	AE24
AR9	VSS12	AE23
AR6	VSS13	AE22
AR3	VSS14	AE21
AP20	VSS15	AE20
AP17	VSS16	AE19
AP13	VSS17	AE18
AP10	VSS18	AE17
AP7	VSS19	AE16
AP4	VSS20	AE15
AP2	VSS21	AE14
AN34	VSS22	AE13
AN31	VSS23	AE12
AN23	VSS24	AE11
AN20	VSS25	AE10
AN17	VSS26	AE9
AM29	VSS27	AE8
AM27	VSS28	AE7
AM25	VSS29	AE6
AM20	VSS30	AE5
AM17	VSS31	AE4
AM14	VSS32	AE3
AM11	VSS33	AE2
AM8	VSS34	AE1
AM2	VSS35	AE0
AL34	VSS36	AE-1
AL31	VSS37	AE-2
AL23	VSS38	AE-3
AL20	VSS39	AE-4
AL17	VSS40	AE-5
AL12	VSS41	AE-6
AL9	VSS42	AE-7
AL6	VSS43	AE-8
AL3	VSS44	AE-9
AK29	VSS45	AE-10
AK27	VSS46	AE-11
AK25	VSS47	AE-12
AK20	VSS48	AE-13
AK17	VSS49	AE-14
AK13	VSS50	AE-15
AK10	VSS51	AE-16
AK7	VSS52	AE-17
AK4	VSS53	AE-18
AK2	VSS54	AE-19
AK1	VSS55	AE-20
AK0	VSS56	AE-21
AK-1	VSS57	AE-22
AK-2	VSS58	AE-23
AK-3	VSS59	AE-24
AK-4	VSS60	AE-25
AK-5	VSS61	AE-26
AK-6	VSS62	AE-27
AK-7	VSS63	AE-28
AK-8	VSS64	AE-29
AK-9	VSS65	AE-30
AK-10	VSS66	AE-31
AK-11	VSS67	AE-32
AK-12	VSS68	AE-33
AK-13	VSS69	AE-34
AK-14	VSS70	AE-35
AK-15	VSS71	AE-36
AK-16	VSS72	AE-37
AK-17	VSS73	AE-38
AK-18	VSS74	AE-39
AK-19	VSS75	AE-40
AK-20	VSS76	AE-41
AK-21	VSS77	AE-42
AK-22	VSS78	AE-43
AK-23	VSS79	AE-44
AK-24	VSS80	AE-45

K27	VSS161
K9	VSS162
K3	VSS163
K32	VSS164
J30	VSS165
J21	VSS166
J19	VSS167
H35	VSS168
H32	VSS169
H28	VSS170
H26	VSS171
H24	VSS172
H22	VSS173
H18	VSS174
H15	VSS175
H13	VSS176
H11	VSS177
H8	VSS178
H5	VSS179
H2	VSS180
G34	VSS181
G31	VSS182
G20	VSS183
G14	VSS184
G6	VSS185
G3	VSS186
F30	VSS187
F27	VSS188
F26	VSS189
F22	VSS190
F19	VSS191
F16	VSS192
F15	VSS193
F12	VSS194
F9	VSS195
F8	VSS196
F4	VSS197
E24	VSS198
E21	VSS199
E18	VSS200
E13	VSS201
E11	VSS202
E8	VSS203
E5	VSS204
E2	VSS205
D33	VSS206
D30	VSS207
D26	VSS208
D9	VSS209
D6	VSS210
D3	VSS211
C34	VSS212
C32	VSS213
C28	VSS214
C26	VSS215
C24	VSS216
C22	VSS217
C20	VSS218
C19	VSS219
C16	VSS220
B31	VSS221
B25	VSS222
B21	VSS223
B18	VSS224
B17	VSS225
B13	VSS226
B11	VSS227
B8	VSS228
B6	VSS229
B4	VSS230
A29	VSS231
A27	VSS232
A23	VSS233
A9	VSS234

VSS

NCTF

VSS NCTF1
VSS NCTF2
VSS NCTF3
VSS NCTF4
VSS NCTF5
VSS NCTF6
VSS NCTF7

1% 3.01K R616
CPU_CFG_7_MN

AP25	RSVD1	RSVD32	AJ13
AL25	RSVD2	RSVD33	AJ12
AL24	RSVD3	RSVD34	AH25
AL22	RSVD4	RSVD35	AK26
AJ33	RSVD5	RSVD36	AL26
AG9	RSVD6	RSVD_NCTF_37	AR2
M27	RSVD7	RSVD38	AJ26
L28	RSVD8	RSVD39	AJ27
L17	SA_DIMM_VREFDQ		
H17	SB_DIMM_VREFDQ		
G25	RSVD11		
G17	RSVD12	RSVD_NCTF_40	AP1
E31	RSVD13	RSVD_NCTF_41	AT2
E30	RSVD14	RSVD_NCTF_42	AT3
		RSVD_NCTF_43	AR1
AM30	CFG_0	RSVD45	AL28
AM28	CFG_1	RSVD46	AL29
AP31	CFG_2	RSVD47	AP30
AL32	CFG_3	RSVD48	AP32
AL30	CFG_4	RSVD49	AL27
AM31	CFG_5	RSVD50	AT31
AN29	CFG_6	RSVD51	AT32
AM32	CFG_7	RSVD52	AP33
AK32	CFG_8	RSVD_NCTF_54	AT33
AK31	CFG_9	RSVD_NCTF_55	AT34
AK28	CFG_10	RSVD_NCTF_56	AP35
AJ28	CFG_11	RSVD_NCTF_57	AR32
AN30	CFG_12	RSVD58	
AK32	CFG_13		
AJ29	CFG_14	RSVD_TP_69	E15
AK30	CFG_15	RSVD_TP_68	F15
AK30	CFG_16	KEY	A2
H16	RSVD_TP_86	RSVD62	C15
		RSVD63	AJ15
		RSVD65	AH15
B19	RSVD15		
A19	RSVD16		
A20	RSVD17		
B20	RSVD18		
U9	RSVD19	RSVD_TP_66	AA5
T9	RSVD20	RSVD_TP_67	AA4
AC9	RSVD21	RSVD_TP_68	R8
AB9	RSVD22	RSVD_TP_69	AD3
		RSVD_TP_70	AD2
		RSVD_TP_71	AA2
		RSVD_TP_72	AA1
		RSVD_TP_73	R9
		RSVD_TP_74	AE3
		RSVD_TP_75	
CL	RSVD_NCTF_23		
A3	RSVD_NCTF_24		
		RSVD_TP_76	V4
		RSVD_TP_77	V5
		RSVD_TP_78	N2
		RSVD_TP_79	AD5
J29	RSVD26	RSVD_TP_80	AD7
J28	RSVD27	RSVD_TP_81	W2
A34	RSVD_NCTF_28	RSVD_TP_82	N3
A33	RSVD_NCTF_29	RSVD_TP_83	AE5
C35	RSVD_NCTF_30	RSVD_TP_84	AD9
B35	RSVD_NCTF_31	RSVD_TP_85	
	(VSS) RSVD86		AP34

RESERVED

CRB is NC
EDS/DG is GND recommend

CFG Straps for Processor

PCI Express Configuration Select	
CFG0	1 : Single PEG 0 : Bifunction enabled

PCI Express Static Lane Reversal	
CFG3	1 : Normal operation 0 : Lane Reversed

Display Port Presence	
CFG4	1 : Disabled - No DP device is connected to eDP 0 : Enabled - (DP device is connected to eDP

PCIe 2.0 SUPPORT	
CFG7	1 : Normal operation 0 : PCIe2.0 Jitter support

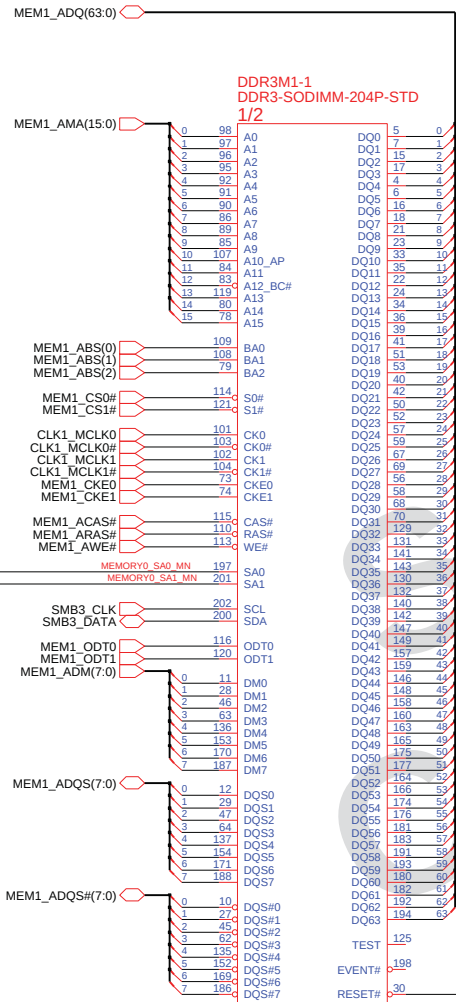
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APPROVAL	MK KIM	REV	REV 0.9			
MODULE CODE	undefined	LAST EDIT				
				October 20, 2009 21:30:55 PM	PAGE	12 OF 56

DDR SO-DIMM #0

Height : 4 mm (STANDARD)

P/N : 3709-001532 (Molex)

P/N : 3709-001560 (Foxconn)

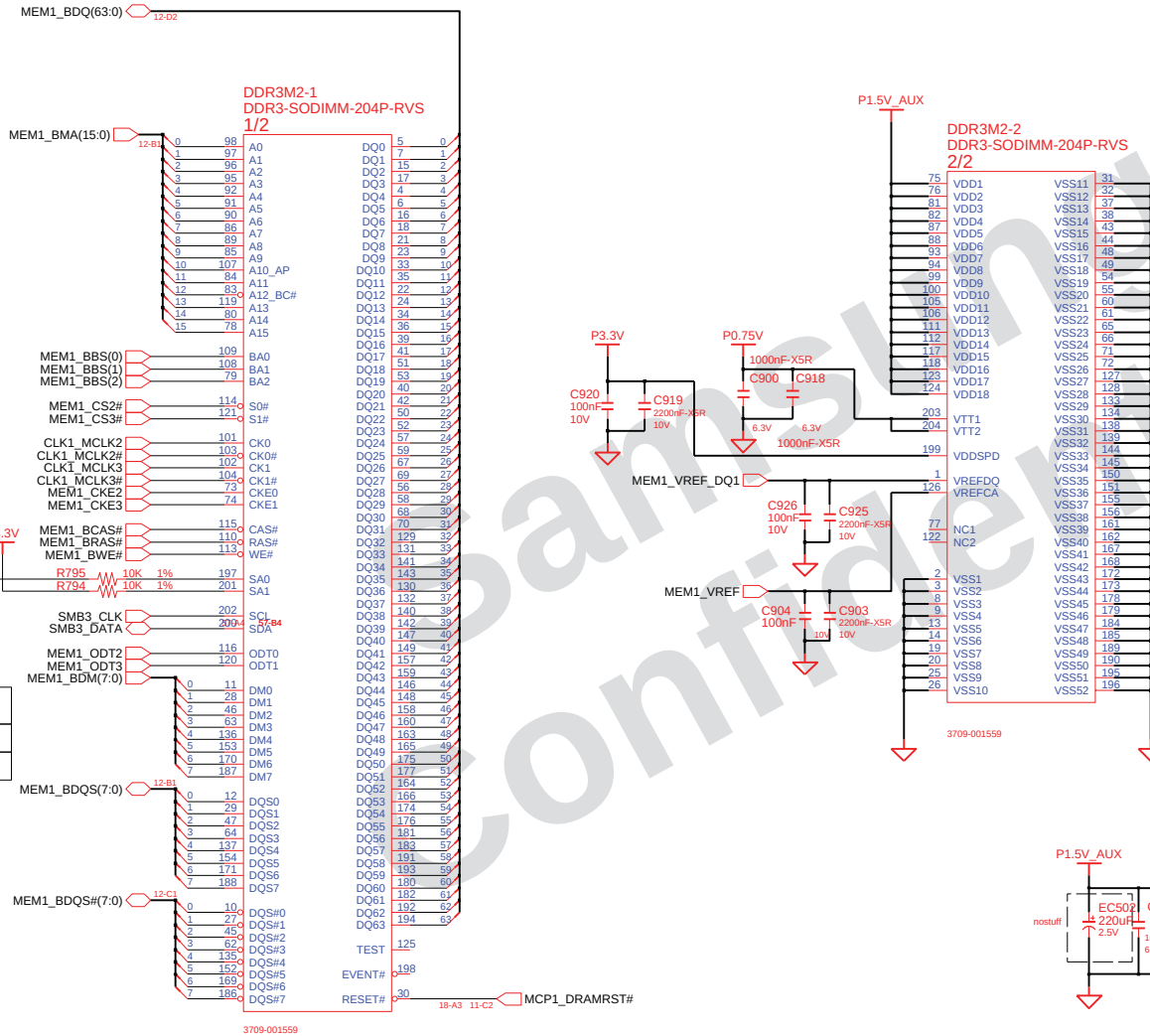


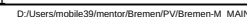
DDR SO-DIMM #1

Height : 4 mm (REVERSE)

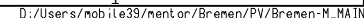
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P/N : 3709-001559 (Foxconn)



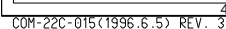


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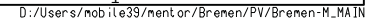
SAMSUNG
ELECTRONICS
PART NO. BA41-01174A

COM-22C-015(1996.6.5) REV. 3

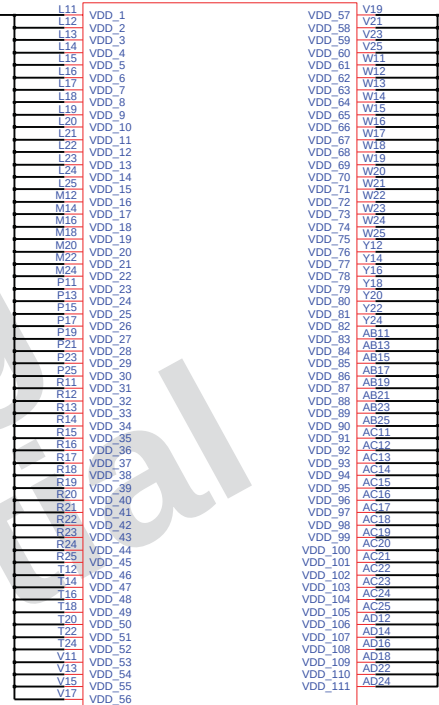


D:/Users/nobile39/mentor/Bremen/PV/Bremen-M_MAIN

D:/Users/mobile39/mentor/Bremen/PV/Bremen-M MAIN



EGFX_CORE

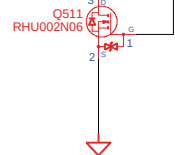
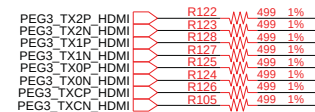
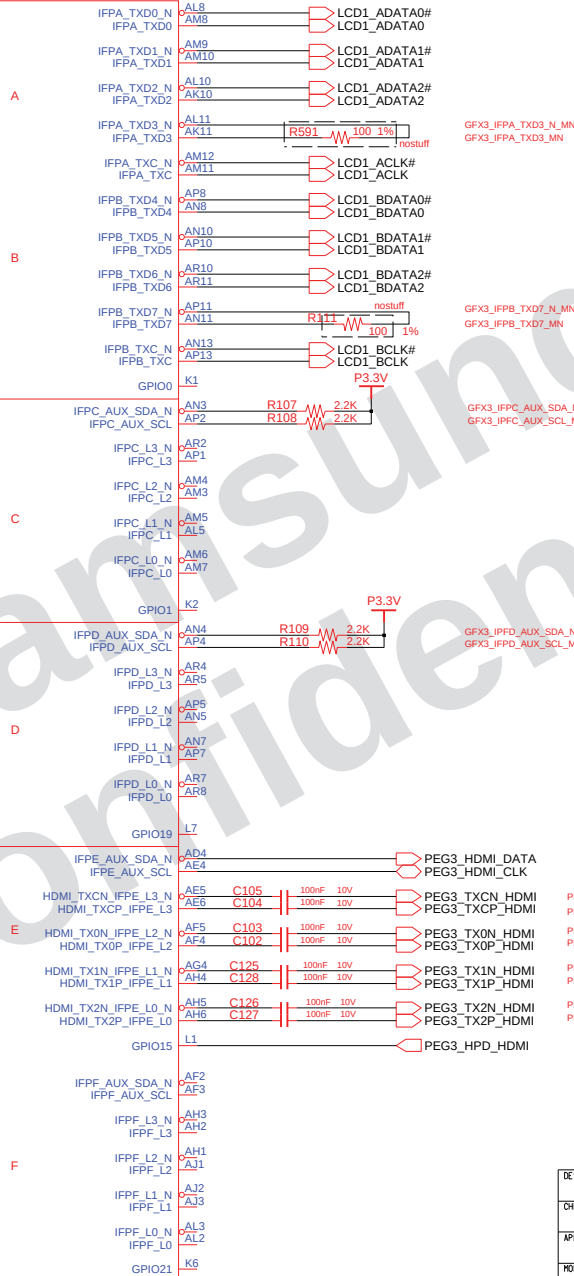
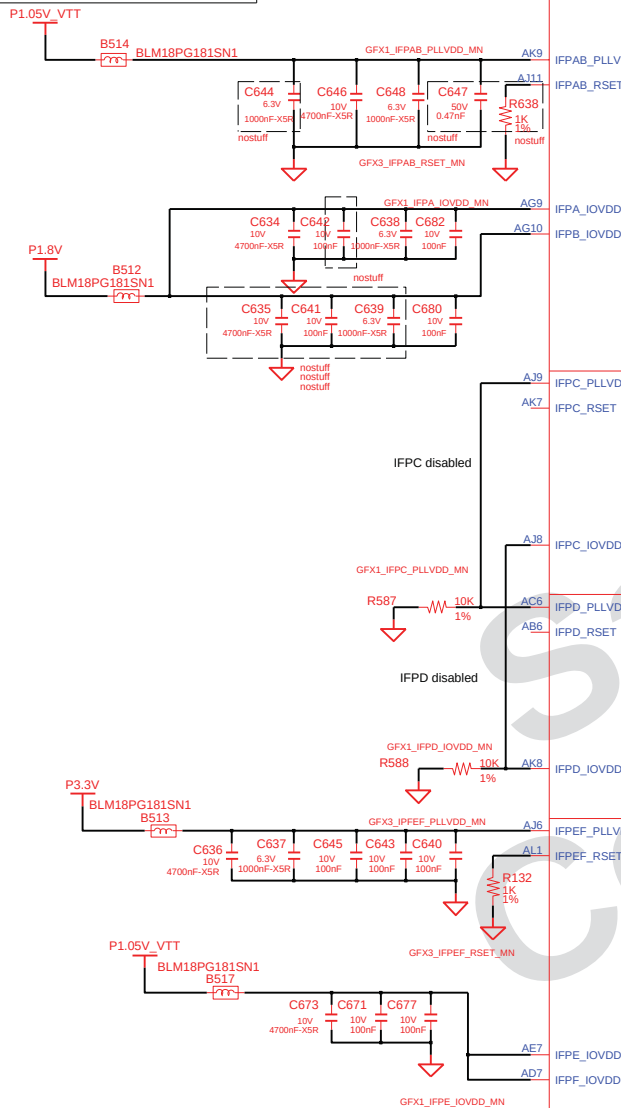


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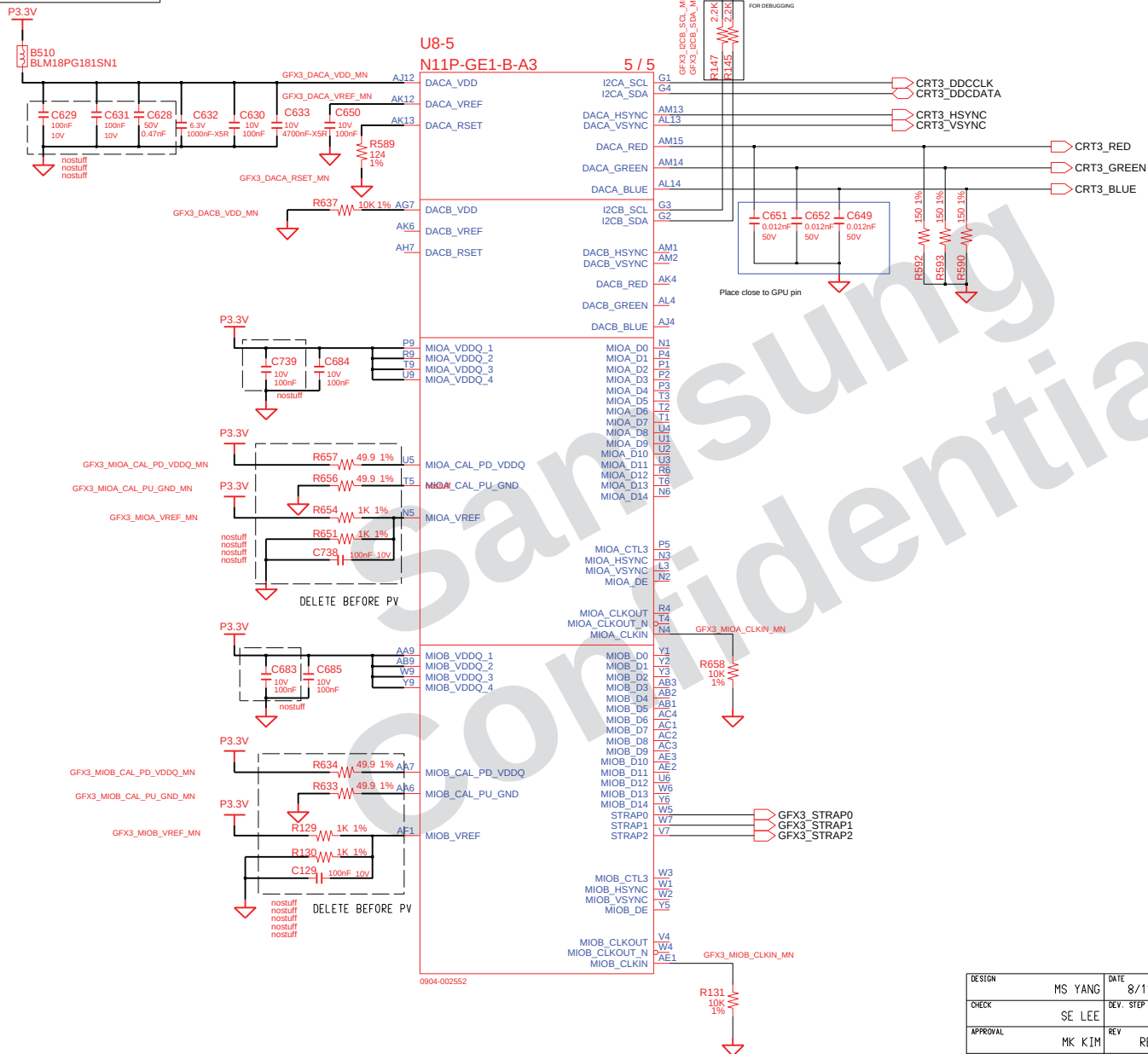
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U8-4
N11P-GE1-B-A3

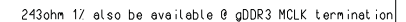
4 / 5



DESIGN	MS YANG	DATE	8/11/2009	TITLE	BREMEN-M N11X_40NM(4/5) N11X_40NM(4/5)	SAMSUNG ELECTRONICS
CHECK	SE LEE	DEV. STEP	PV			PART NO. BA41-01174A
APPROVAL	MK KIM	REV	REV 0.9			
MODULE CODE		LAST EDIT		October 20, 2009 21:30:55 PM	PAGE 23	OF 56

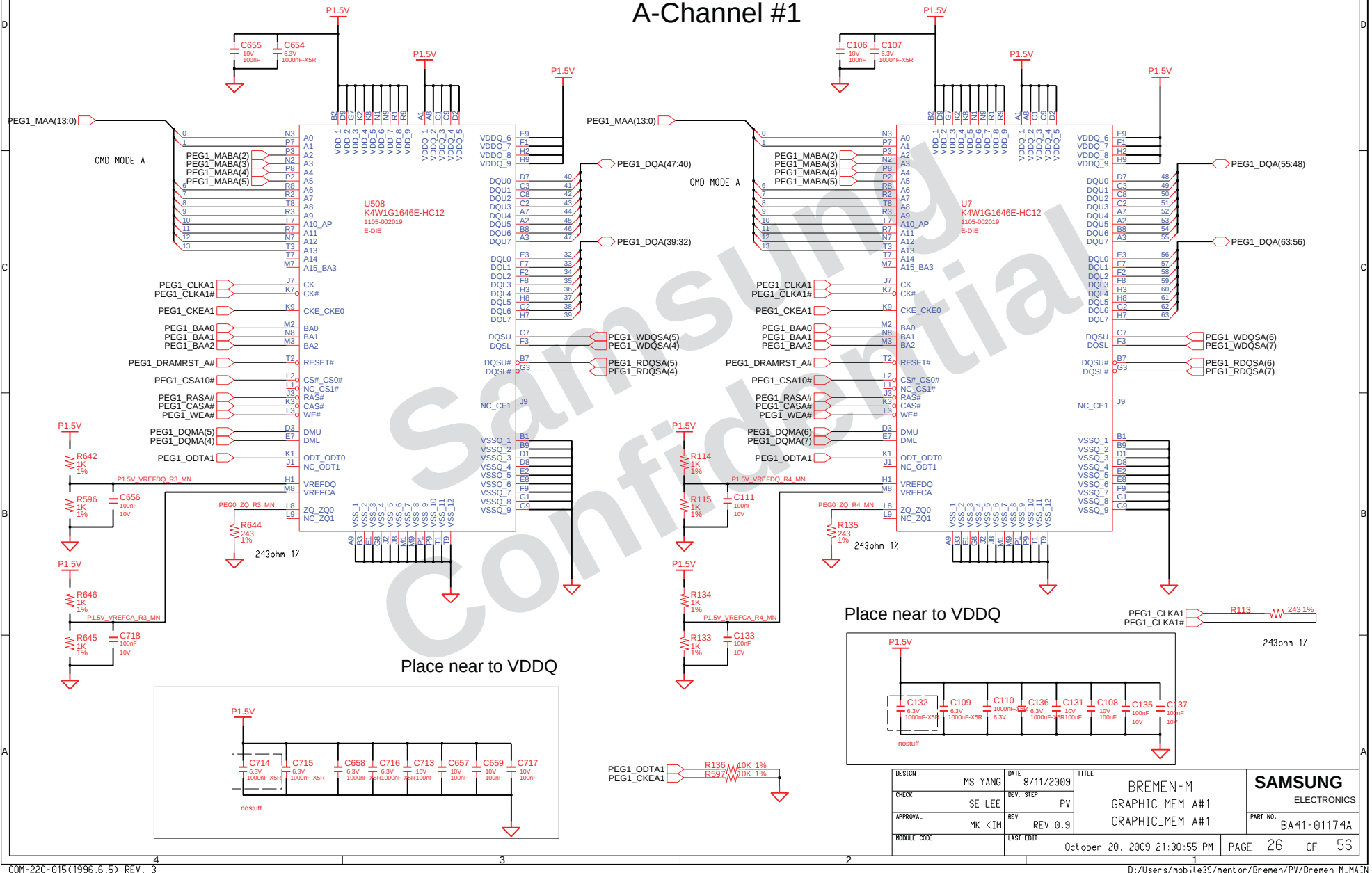


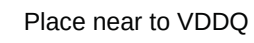
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CHECK	SE LEE	DEV. STEP	PV			PART NO. BA41-01174A
APPROVAL	MK KIM	REV	REV 0.9			
MODULE CODE		LAST EDIT		October 20, 2009 21:30:55 PM	PAGE 24 OF 56	



DESIGN	MS YANG	DATE	8/11/2009	TITLE BREMEN-M GRAPHIC_MEM A#0 GRAPHIC_MEM A#0	SAMSUNG ELECTRONICS
CHECK	SE LEE	REV. STEP	PV		
APPROVAL	MK KIM	REV	REV 0.9		
MODULE CODE		LAST EDIT	October 20, 2009 21:30:55 PM		
				PAGE	25 OF 56

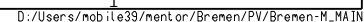
A-Channel #1





COM-22C-015(1996.6.5) REV. 3

1

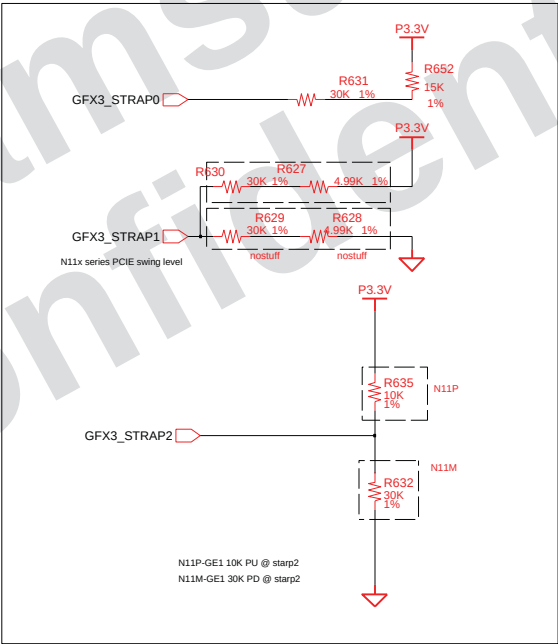
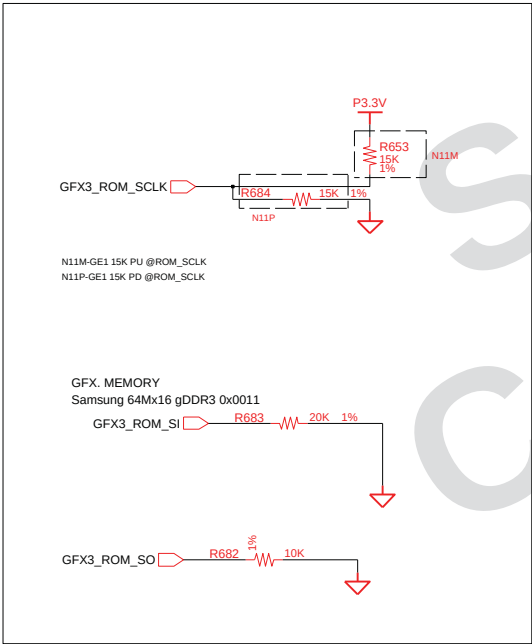


DESIGN	MS YANG	DATE	8/11/2009	TITLE BREMEN-M GRAPHIC_MEM C#1 GRAPHIC_MEM C#1	SAMSUNG ELECTRONICS			
CHECK	SE LEE	REV. STEP	PV					
APPROVAL	MK KIM	REV	REV 0.9				PART NO.	BA41-01174A
MODULE CODE	LAST EDIT		October 20, 2009 21:30:55 PM				PAGE	28 OF 56

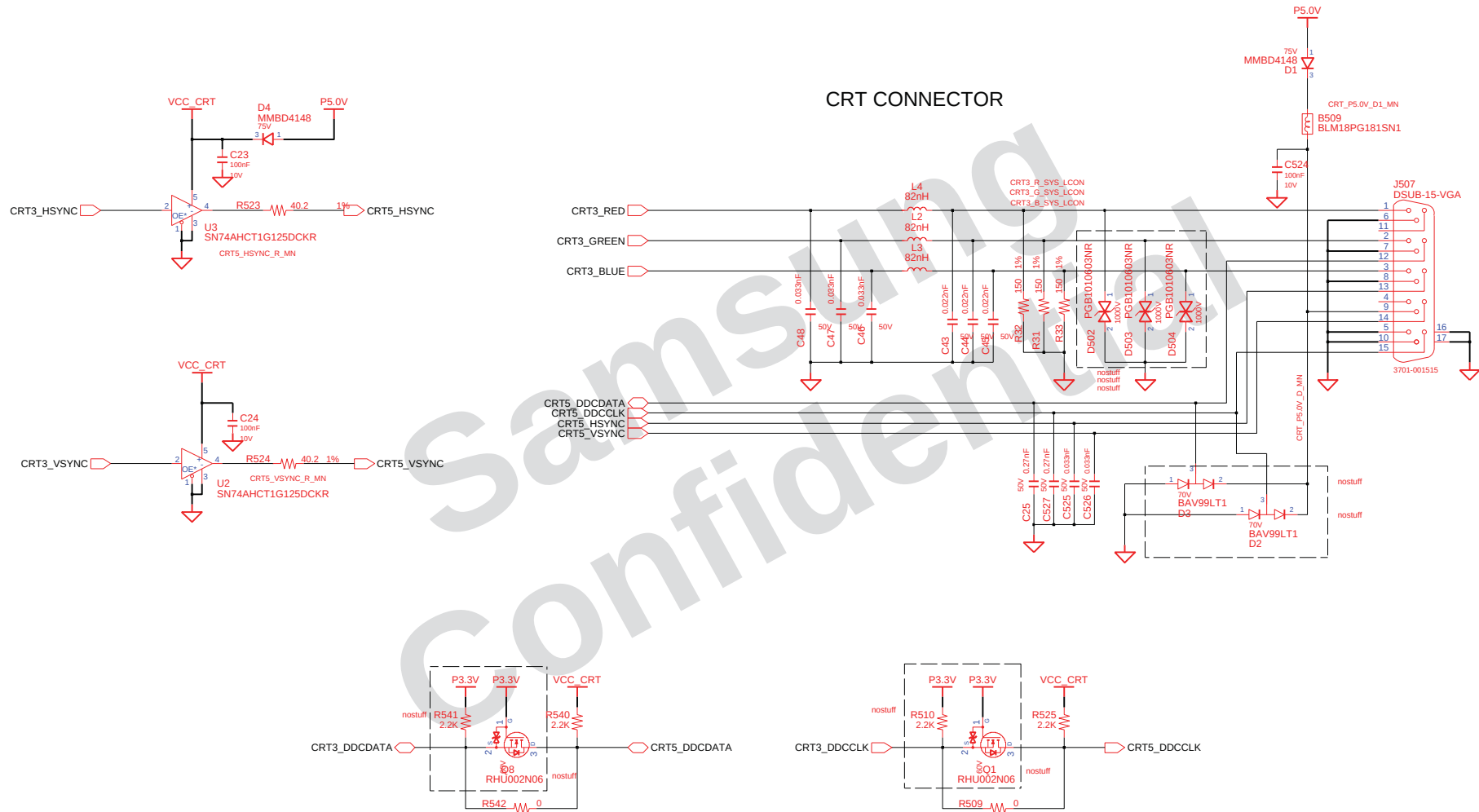
N11x_40nm STRAP

STRAP PIN	BIT 3	BIT 2	BIT 1	BIT0
ROM_SO	XCLK_417	FB_0_BAR_SIZE	SMB_ALT_ADDR	VGA_DEVICE
ROM_SCLK	PCI_DEVID[4]	SUB_VENDOR	SLOT_CLK_CFG	PEX_PLL_EN_TERM
ROM_SI	RAMCFG[3]	RAMCFG[2]	RAMCFG[1]	RAMCFG[0]
STRAP2	PCI_DEVID[3]	PCI_DEVID[2]	PCI_DEVID[1]	PCI_DEVID[0]
STRAP1	3GIO_PADCFG[3]	3GIO_PADCFG[2]	3GIO_PADCFG[1]	3GIO_PADCFG[0]
STRAP0	USER[3]	USER[2]	USER[1]	USER[0]

RESISTOR	PULL UP	PULL DOWN
5K	1000	0000
10K	1001	0001
15K	1010	0010
20K	1011	0011
25K	1100	0100
30K	1101	0101
35K	1110	0110
45K	1111	0111



CRT



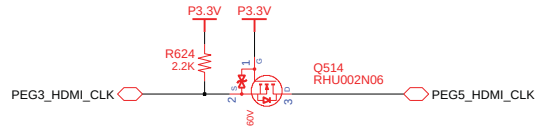
DESIGN	MS YANG	DATE	8/11/2009	TITLE	BREMEN-M GRAPHICS_IF CRT	SAMSUNG ELECTRONICS
CHECK	SE LEE	DEV. STEP	PV			PART NO. BA41-01174A
APPROVAL	MK KIM	REV	REV 0.9			
MODULE CODE		LAST EDIT				

October 20, 2009 21:30:55 PM

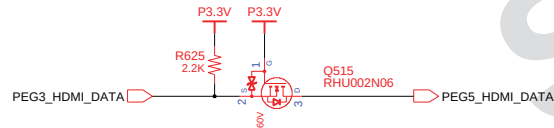
PAGE 31 OF 56

HDMI

FOR HDMI VERIFICATION TEST



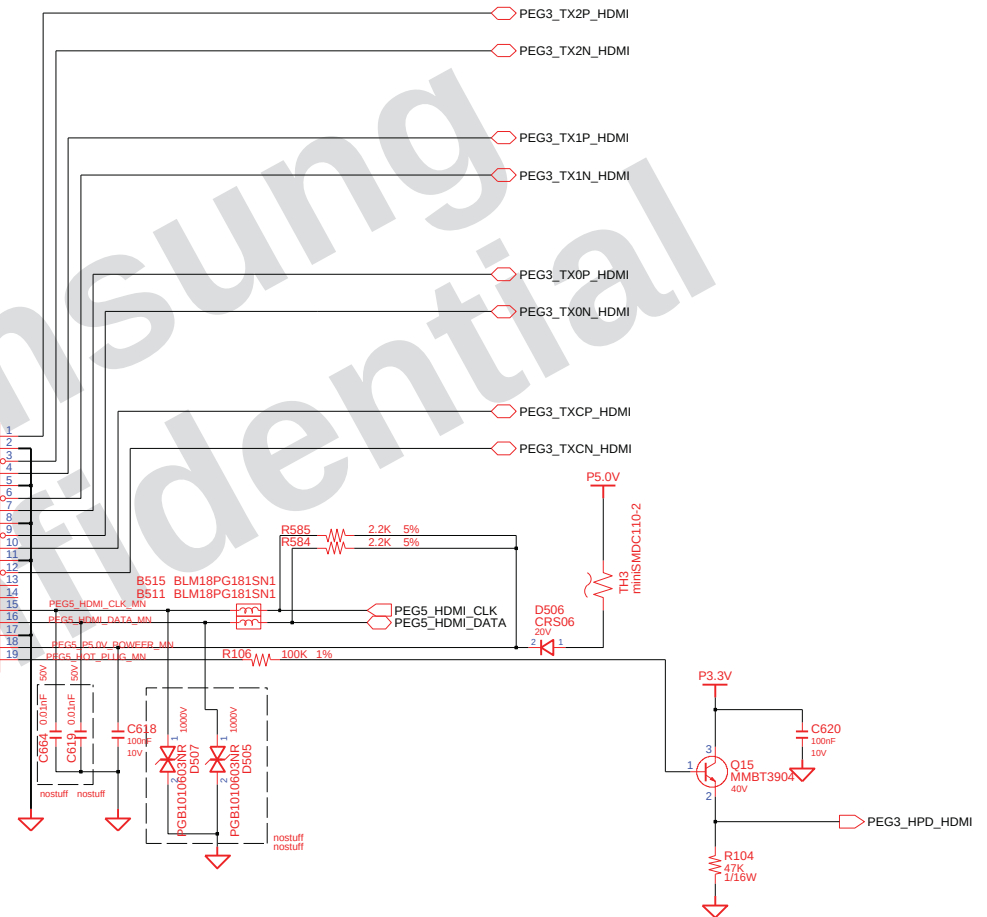
N10x/N11x_40nm HDMI/DP/LVDS support only 3.3V voltage tolerance



J514
HDMI-19P-FEMALE

- 1 TMDS_DATA2
- 2 TMDS_DATA2_SHIELD
- 3 TMDS_DATA2#
- 4 TMDS_DATA1
- 5 TMDS_DATA1_SHIELD
- 6 TMDS_DATA1#
- 7 TMDS_DATA0
- 8 TMDS_DATA0_SHIELD
- 9 TMDS_DATA0#
- 10 TMDS_CLOCK
- 11 TMDS_CLOCK_SHIELD
- 12 TMDS_CLOCK#
- 13 RESERVED
- 14 CEC
- 15 SCL
- 16 SDA
- 17 MNT1
- 18 MNT2
- 19 MNT3
- 20 MNT4
- 21 DDC_GROUND
- 22 5V_POWER
- 23 HOT_PLUG_DETECT

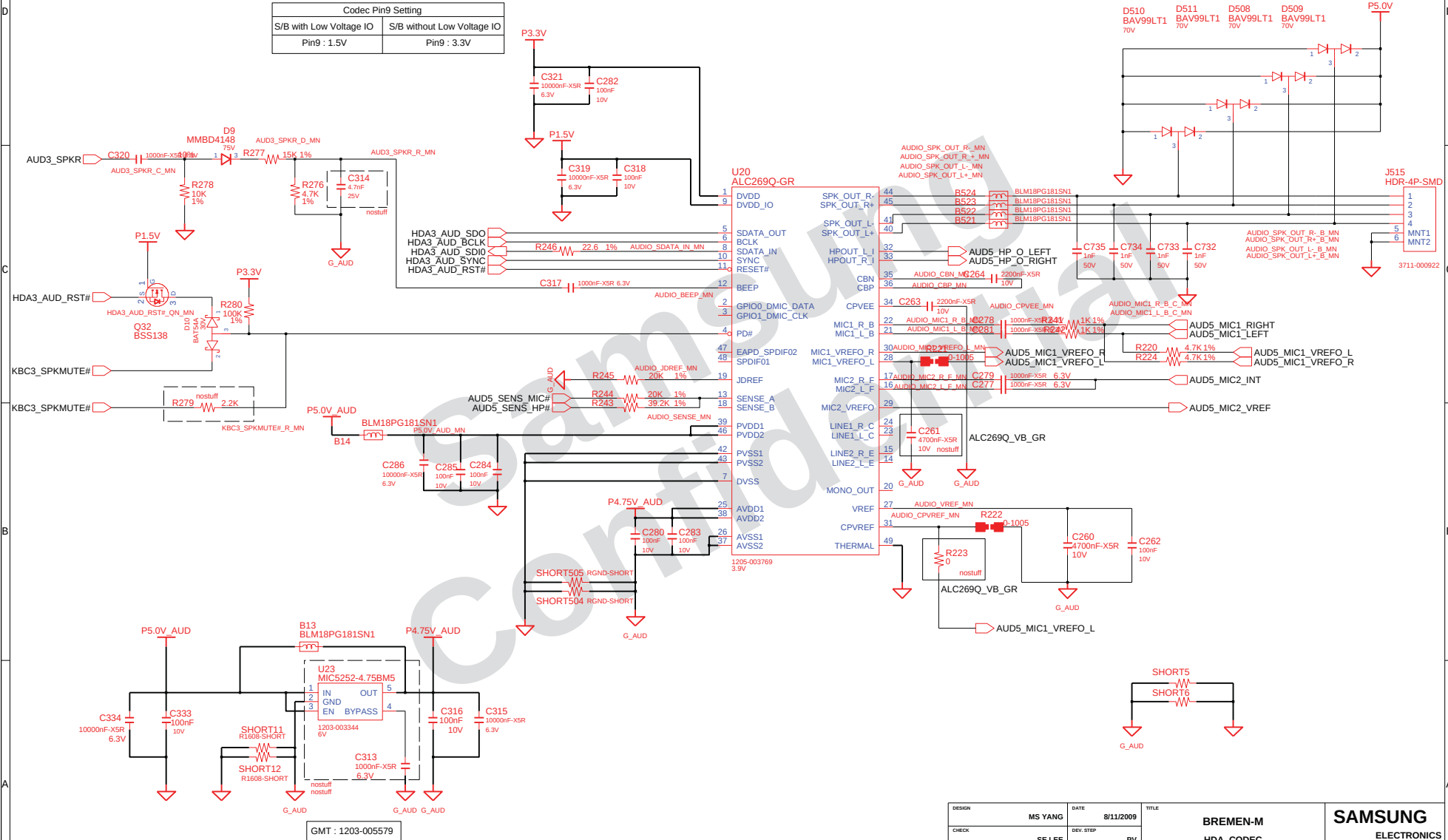
3701-001597



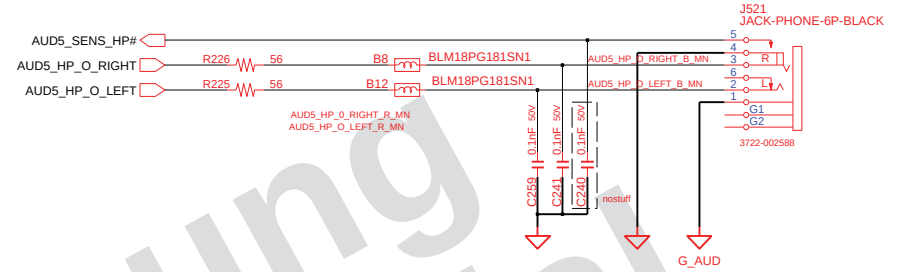
DESIGN	MS YANG	DATE	8/11/2009	TITLE	BREMEN-M GRAPHICS_IF HDMI	SAMSUNG ELECTRONICS
CHECK	SE LEE	DEV. STEP	PV			
APPROVAL	MK KIM	REV	REV 0.9			
MODULE CODE		LAST EDIT				
				October 20, 2009 21:30:55 PM	PAGE 32 OF 56	

HD AUDIO

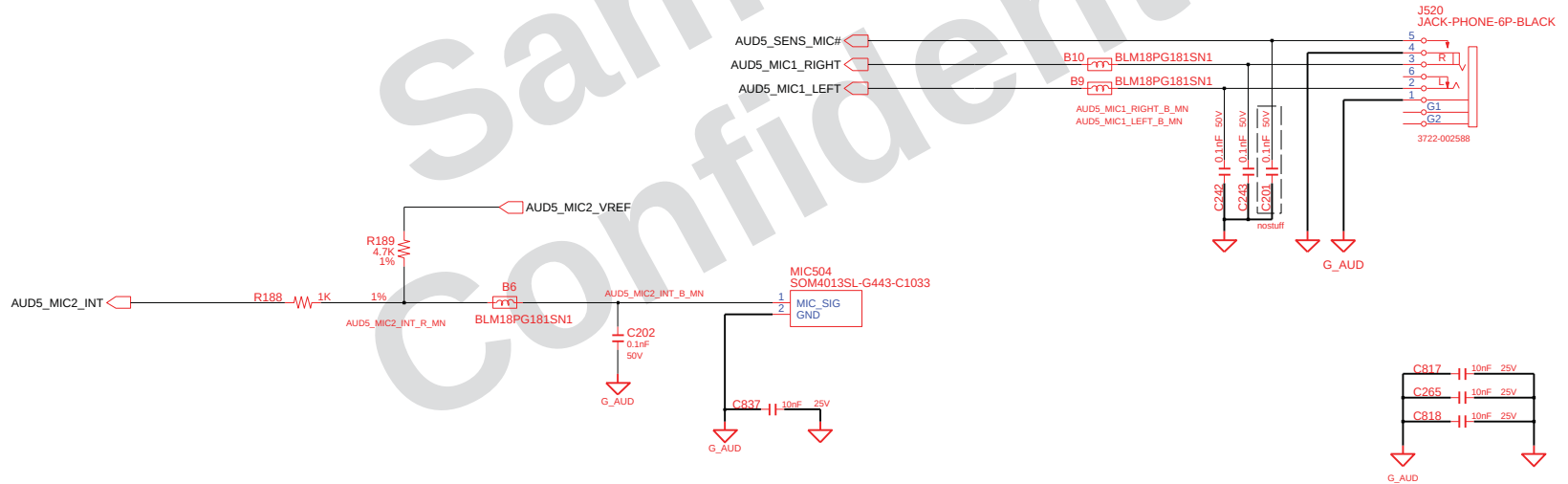
Codec Pin9 Setting	
S/B with Low Voltage IO	S/B without Low Voltage IO
Pin9 : 1.5V	Pin9 : 3.3V



HEADPHONE(BLACK)



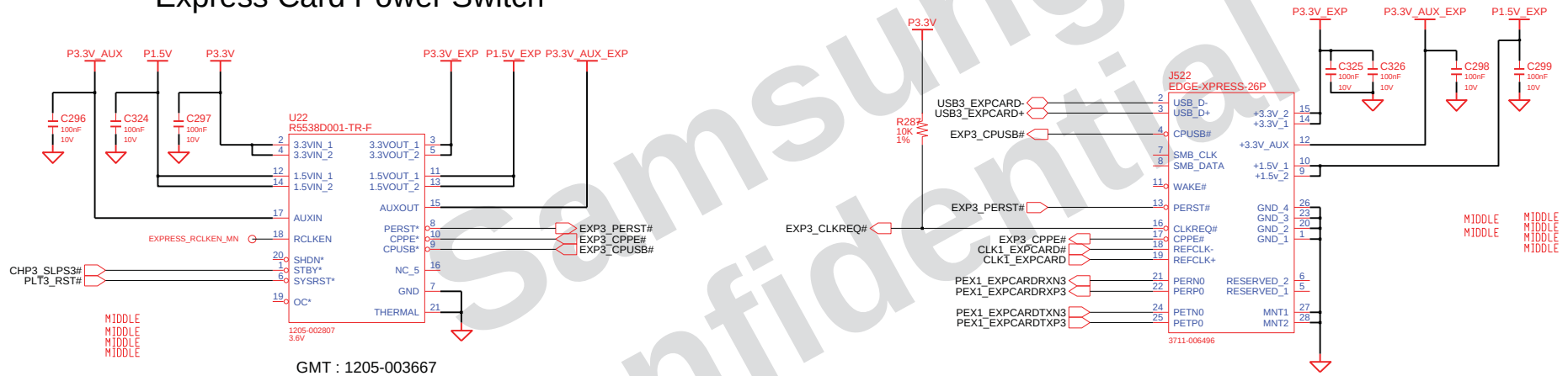
MIC JACK(BLACK)



DESIGN	MS YANG	DATE	8/11/2009	TITLE	BREMEN-M HDA_CODEC AUDIO JACK	SAMSUNG ELECTRONICS
CHECK	SE LEE	DEV. STEP	PV			
APPROVAL	MK KIM	REV	REV 0.9			
MODULE CODE		LAST EDIT				
				October 20, 2009 21:30:55 PM	PAGE 34	OF 56

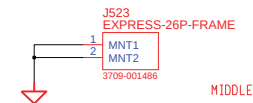
Express Card

Express Card Power Switch



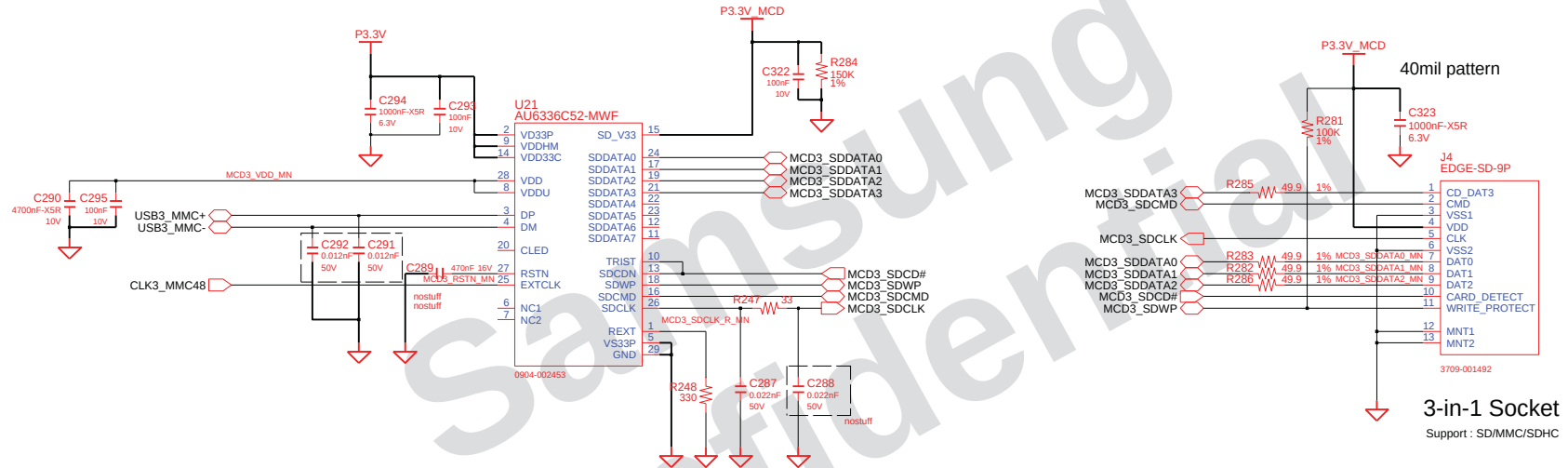
GMT : 1205-003667

TYPE - I



DESIGN	MS YANG	DATE	8/11/2009	TITLE	BREMEN-M EXPRESS CARD	SAMSUNG ELECTRONICS
CHECK	SE LEE	DEV. STEP	PV	REV	EXPRESS CARD	PART NO. BA41-01174A
APPROVAL	MK KIM	REV	REV 0.9	LAST EDIT	October 20, 2009 21:30:55 PM	PAGE 36 OF 56
MODULE CODE						

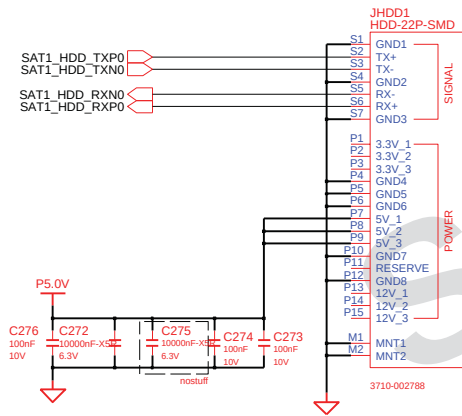
3 IN 1 CARD (AU6336)



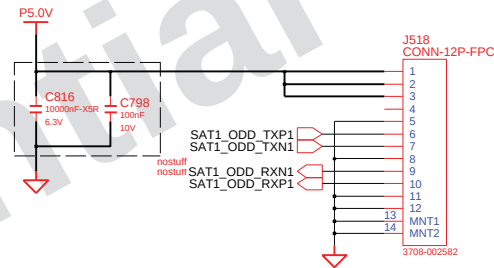
DESIGN	MS YANG	DATE	8/11/2009	TITLE	BREMEN-M MULTICARD	SAMSUNG ELECTRONICS
CHECK	SE LEE	DEV. STEP	PV			
APPROVAL	MK KIM	REV	REV 0.9		3 IN 1 CARD(GL8275)	PART NO. BA41-01174A
MODULE CODE		LAST EDIT				
				October 20, 2009 21:30:55 PM	PAGE	37 OF 56

SATA I/F CONN

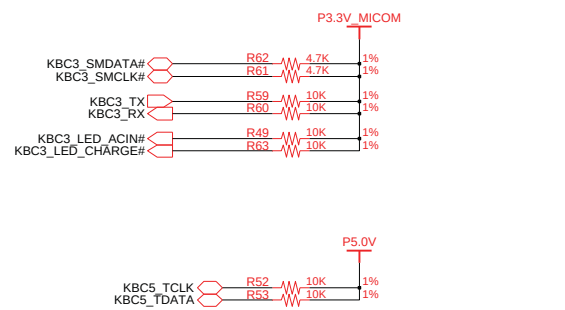
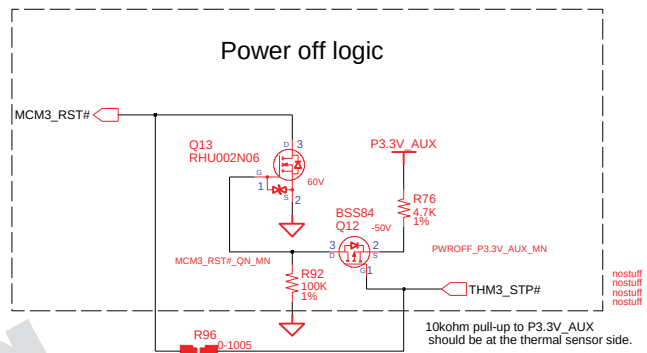
SATA HDD CONN



MAIN TO SUB SATA ODD CONN



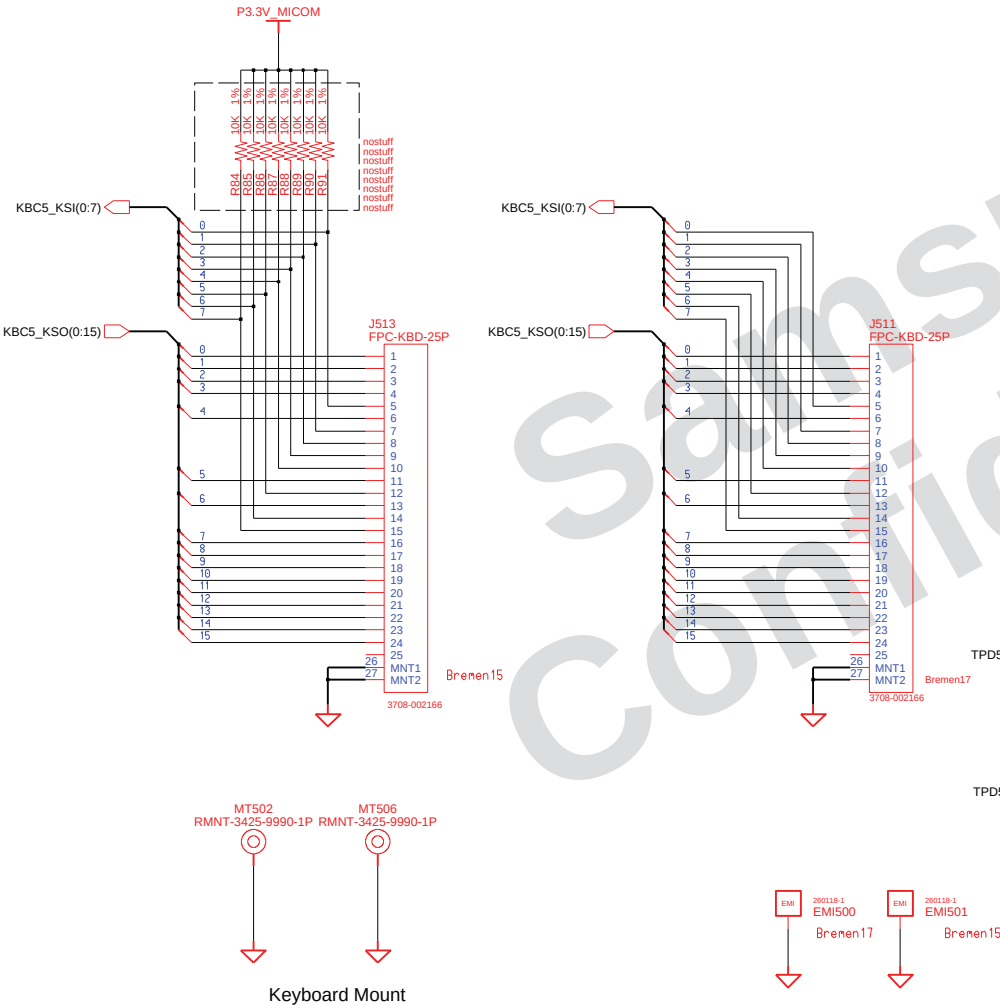
DESIGN	MS YANG	DATE	8/11/2009	TITLE	BREMEN-M SATA DEVICES	SAMSUNG ELECTRONICS
CHECK	SE LEE	DEV. STEP	PV			
APPROVAL	MK KIM	REV	REV 0.9	HDD & ODD SUB CONNECTOR	PART NO. BA41-01174A	
MODULE CODE		LAST EDIT		October 20, 2009 21:30:55 PM	PAGE 39	OF 56



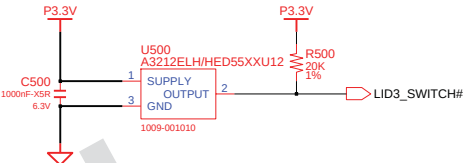
DRWN	MS YANG	DATE	8/11/2009	TITLE BREMEN-M MICOM			
CHECK	SE LEE	DEV. STEP	PV				
APPROVAL	MK KIM	REV	REV 0.9	MICOM_SMSC_MEC1308		PART NO.	BA11-01174A
MODULE CODE		LAST EDIT		October 20, 2009 21:30:55 PM		PAGE	40 OF 56

Micom Glue Logic

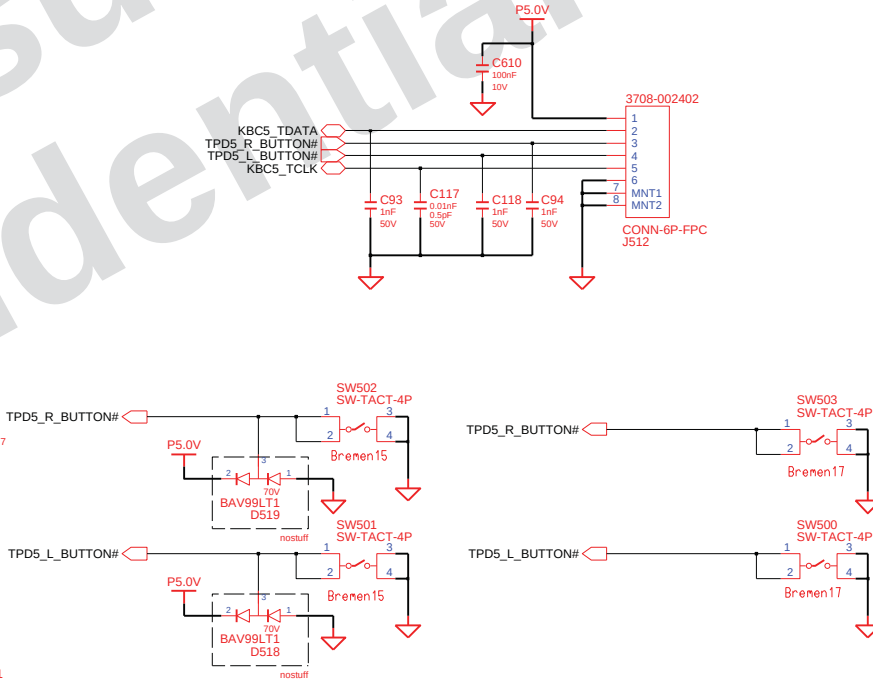
KEYBOARD



LID_SWITCH

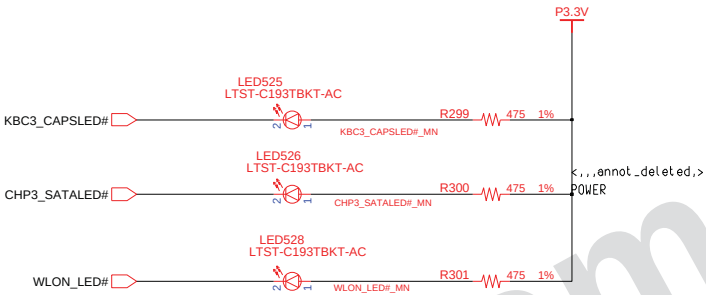


TOUCHPAD

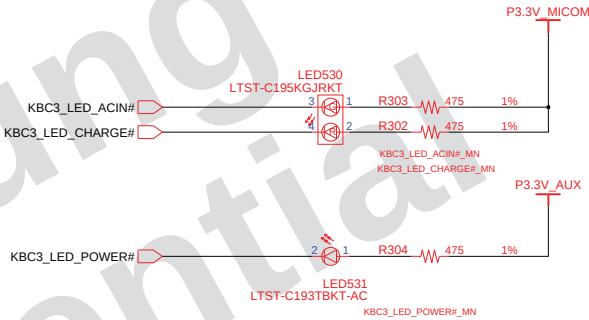


DESIGN	MS YANG	DATE	8/11/2009	TITLE	BREMEN-M MICOM GLUE LOGIC KETBOARD & TOUCHPAD	SAMSUNG ELECTRONICS
CHECK	SE LEE	DEV. STEP	PV			
APPROVAL	MK KIM	REV	REV 0.9			
MODULE CODE		LAST EDIT				
				October 20, 2009 21:30:55 PM	PAGE 41	OF 56

FUNCTION KEY LED



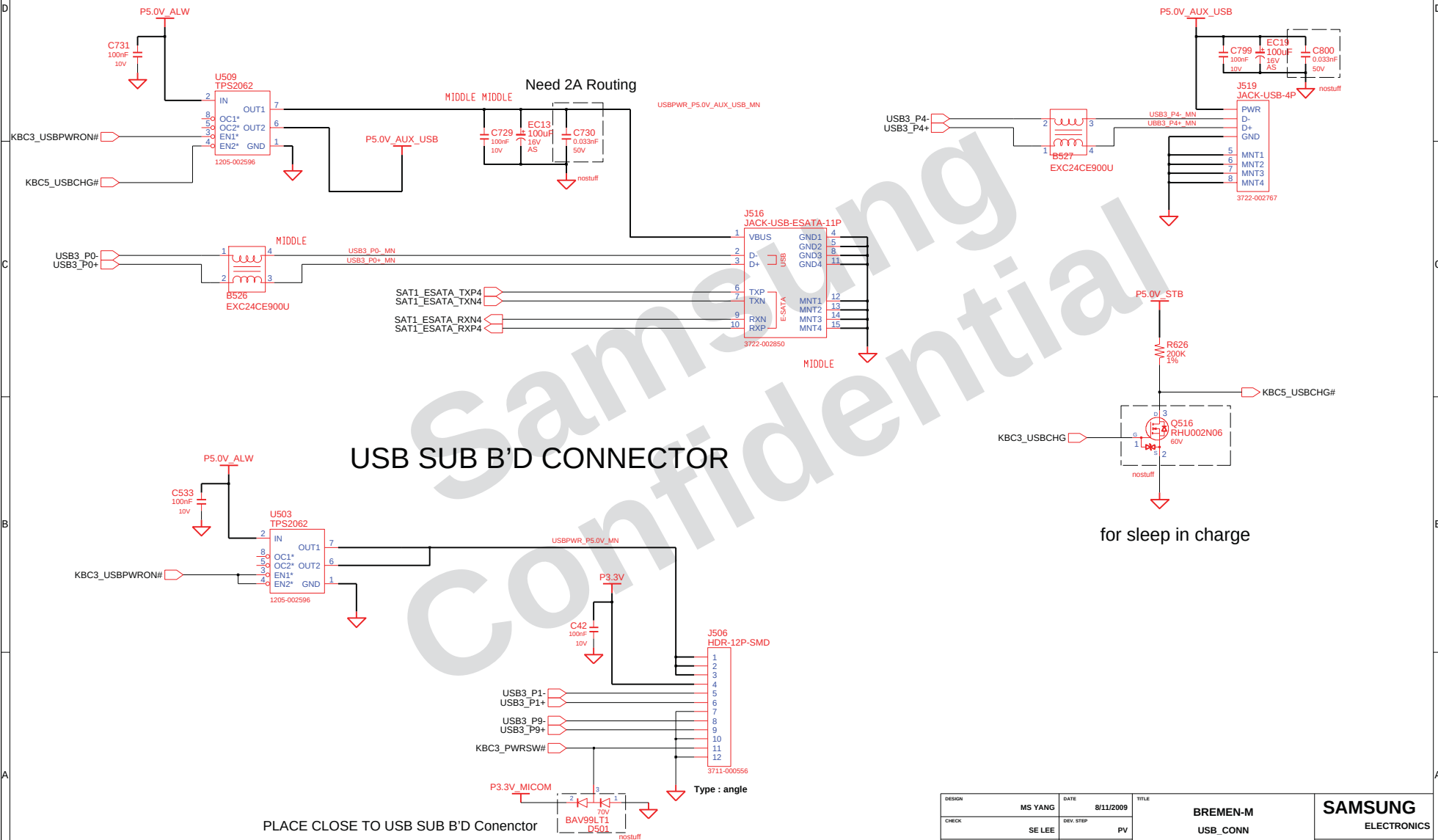
ADAPTERIN/CHARGING LED



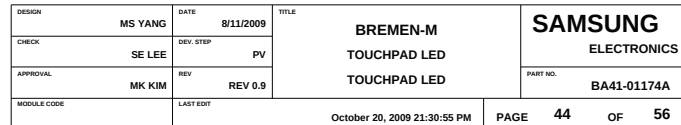
DRAW	MS YANG	DATE	8/11/2009	BREMEN-M LED_SWITCH		SAMSUNG ELECTRONICS			
CHECK	SE LEE	DEV. STEP	PV						
APPROVAL	MK KIM	REV	REV 0.9	LED_SWITCH		PART NO.			
						BA41-01174A			
MODULE CODE		LAST EDIT October 20, 2009 21:30:55 PM				PAGE	42	OF	56

USB + eSATA CONNECTOR

USB Single connector

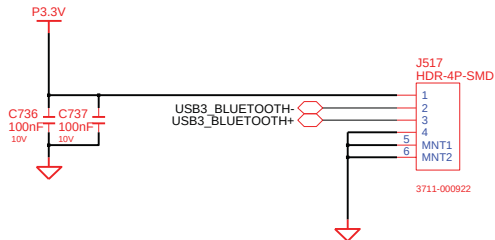


DESIGN	MS YANG	DATE	8/11/2009	TITLE	BREMEN-M USB_CONN	SAMSUNG ELECTRONICS
CHECK	SE LEE	DEV. STEP	PV			
APPROVAL	MK KIM	REV	REV 0.9		USB & eSATA	PART NO. BA41-01174A
MODULE CODE	LAST EDIT		October 20, 2009 21:30:55 PM		PAGE	43 OF 56

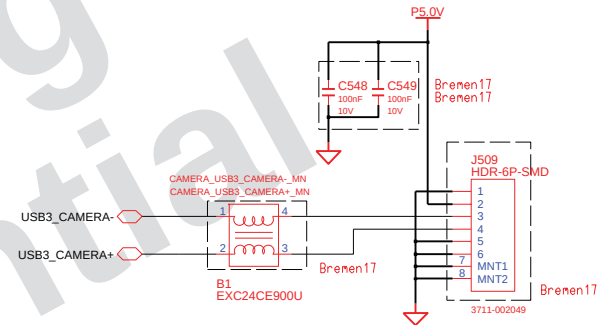


USB I/F Devices

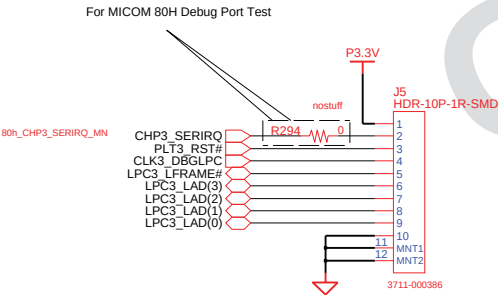
Bluetooth Interface



CAMERA (17Inch)

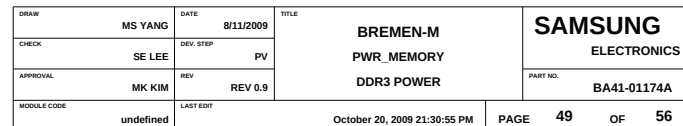


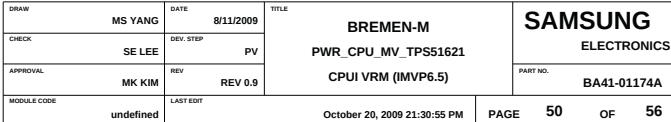
80h PORT DEBUG



DESIGN	MS YANG	DATE	8/11/2009	TITLE	BREMEN-M USB_DEVICES	SAMSUNG ELECTRONICS
CHECK	SE LEE	DEV. STEP	PV			
APPROVAL	MK KIM	REV	REV 0.9		BLUETOOTH & CAMERA	PART NO. BA41-01174A
MODULE CODE		LAST EDIT				

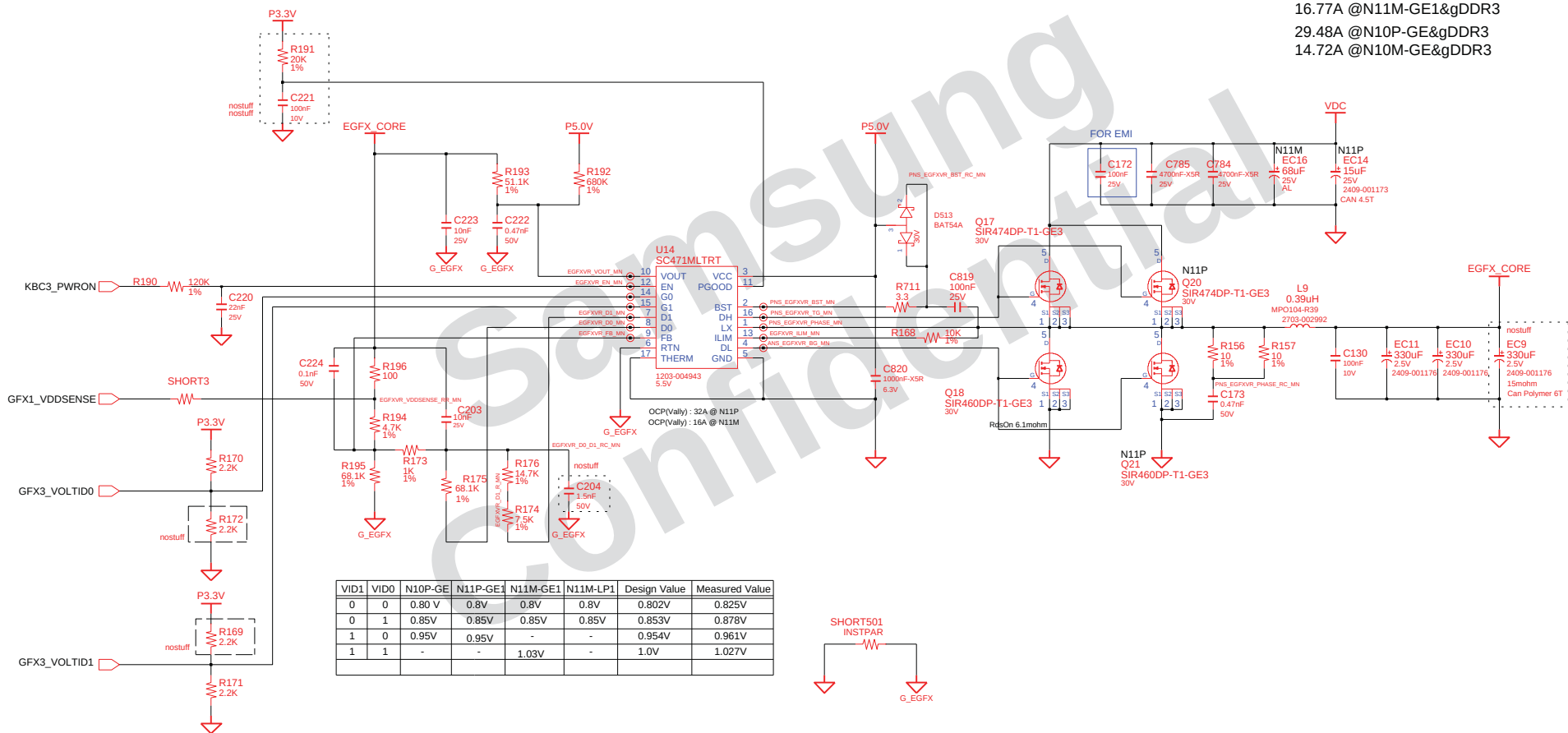






External Graphic Core Power

31.66A @N11P-GE1&gDDR3
16.77A @N11M-GE1&gDDR3
29.48A @N10P-GE&gDDR3
14.72A @N10M-GE&gDDR3



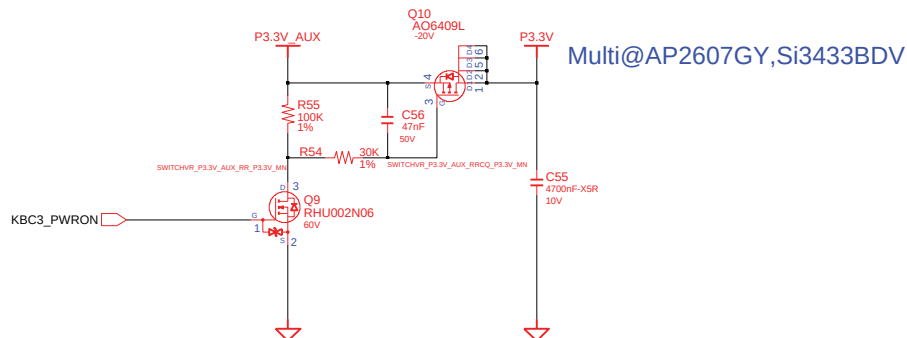
DESIGN	MS YANG	DATE	8/11/2009	TITLE	BREMEN-M PWR_GFX_MV_EXT External Graphic Power	SAMSUNG ELECTRONICS
CHECK	SE LEE	DEV. STEP	PV	REV	REV 0.9	PART NO. BA41-01174A
APPROVAL	MK KIM	LAST EDIT				
MODULE CODE						

October 20, 2009 21:30:55 PM

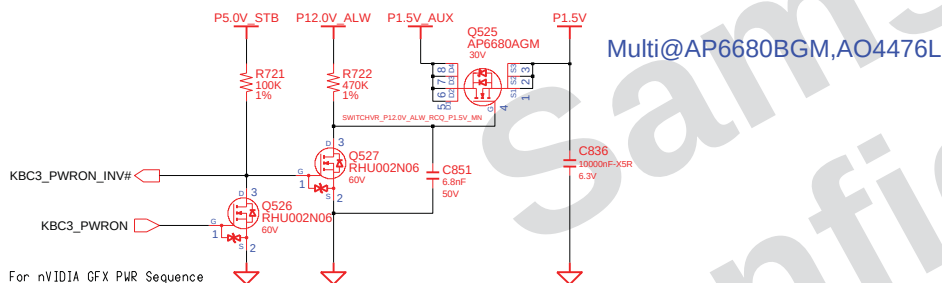
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Switched Power

Switched Power On (P3.3V)



Switched Power On (P1.5V)

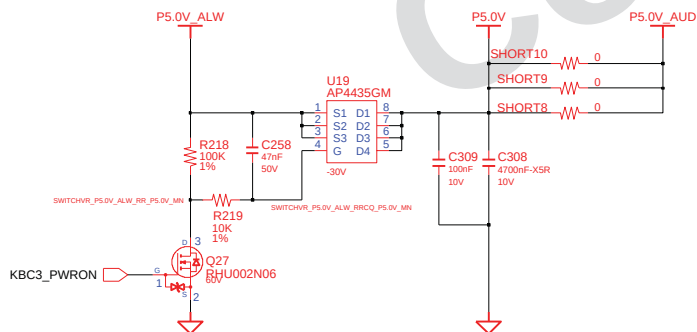


For nVIDIA GFX PWR Sequence

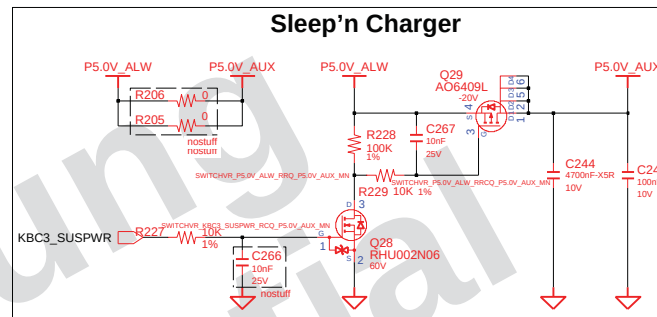
NVDD(EGFX_CORE) first and then FBVDDQ(gDDR3)

Switched Power On (P5.0V)

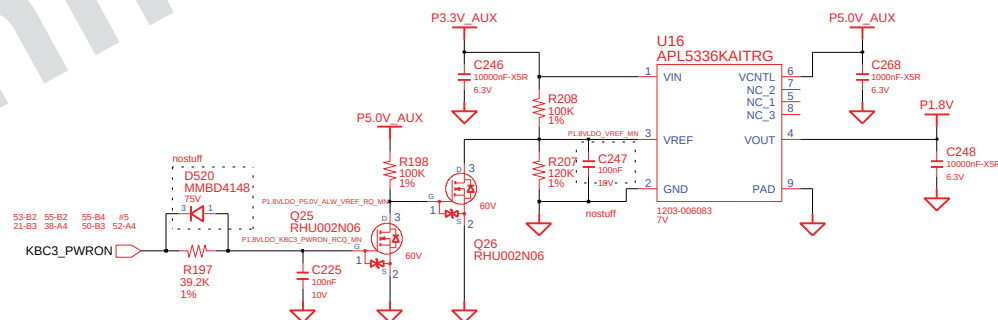
Multi@Si443DDY



Sleep'n Charger

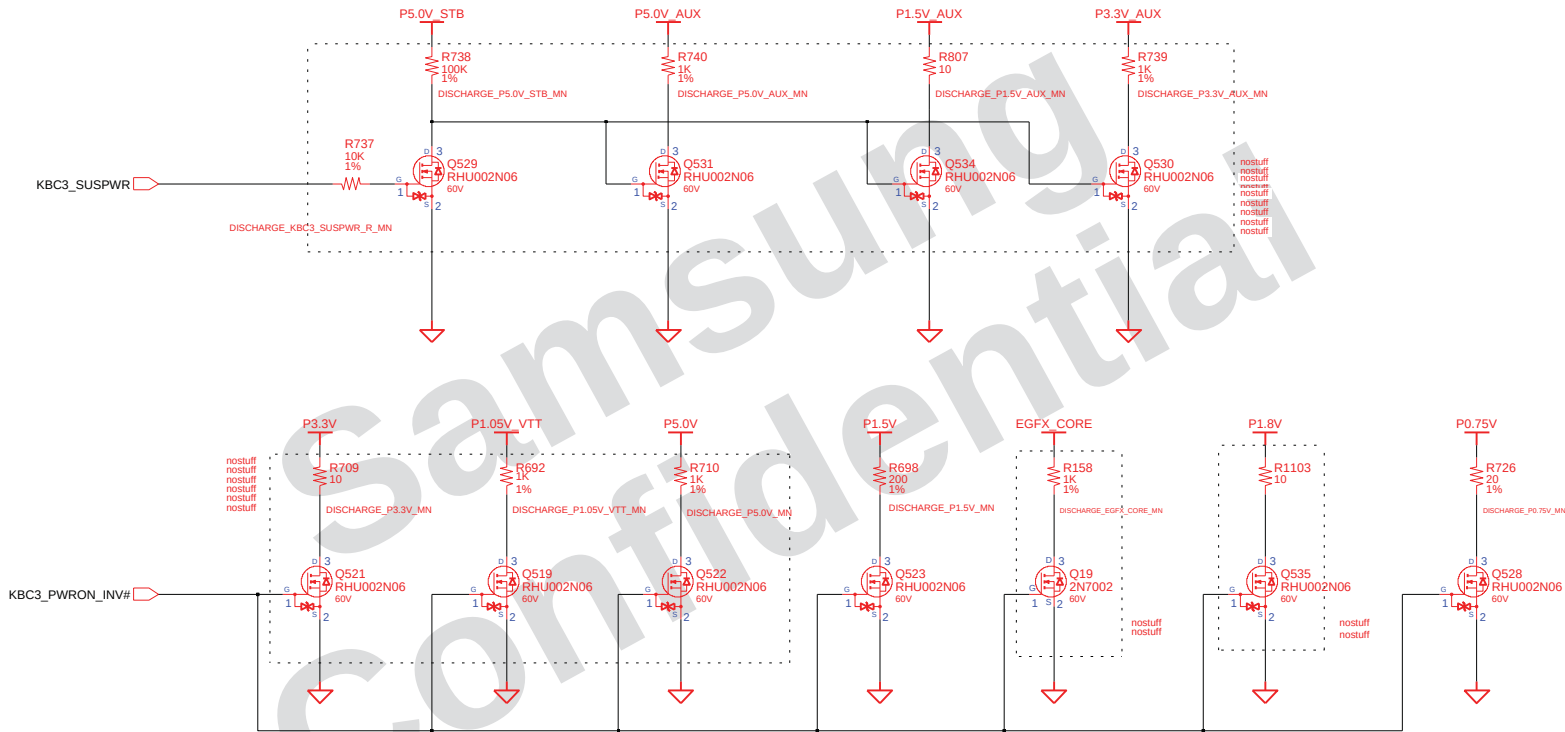


P1.8V(LDO)



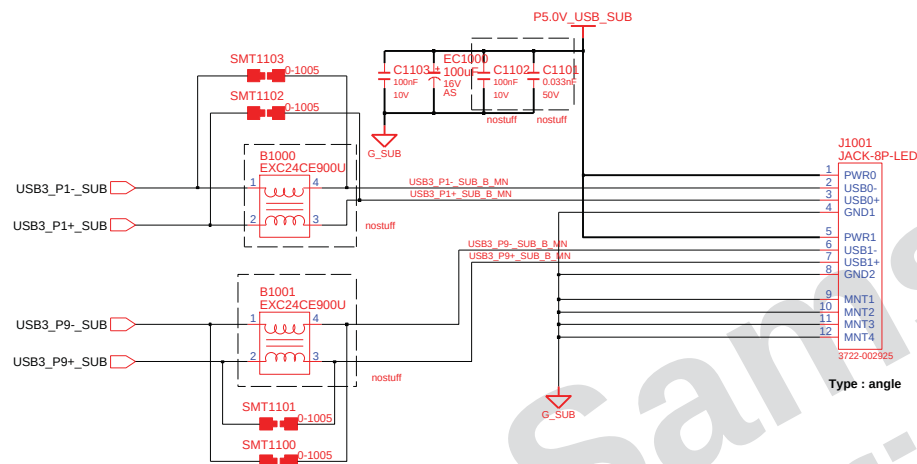
DRAW	MS YANG	DATE	8/11/2009	TITLE	BREMEN-M PWR_MV_SWITCHED SWITCHED POWER	SAMSUNG ELECTRONICS
CHECK	SE LEE	DEV. STEP	PV			PART NO. BA41-01174A
APPROVAL	MK KIM	REV	REV 0.9			
MODULE CODE		LAST EDIT				
October 20, 2009 21:30:55 PM						PAGE 52 OF 56

POWER DISCHARGER

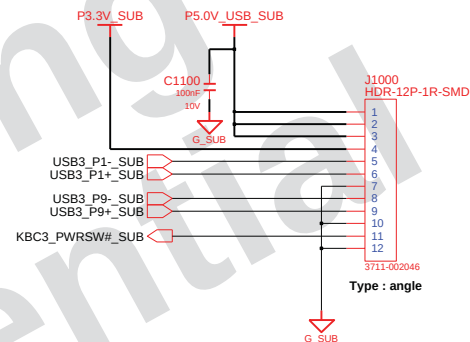


DRAW	MS YANG	DATE	8/11/2009	TITLE	BREMEN-M PWR_MV_DISCHARGER DISCHARGING LOGIC	SAMSUNG ELECTRONICS PART NO. BA41-01174A			
CHECK	SE LEE	DEV. STEP	PV						
APPROVAL	MK KIM	REV	REV 0.9						
MODULE CODE	undefined	LAST EDIT	October 20, 2009 21:30:55 PM			PAGE	53	OF	56

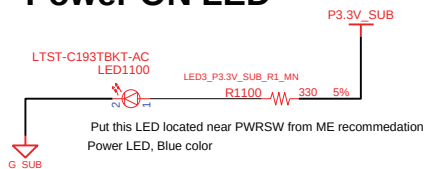
2 USB PORT & POWER S/W SUB B'D



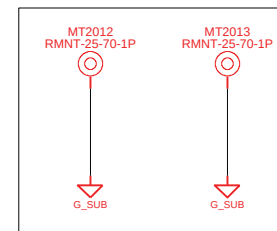
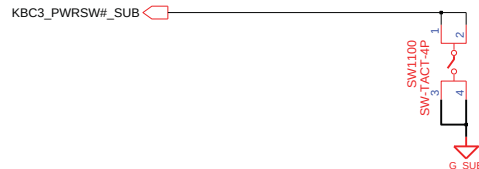
SUB TO MAIN USB CONN



Power ON LED



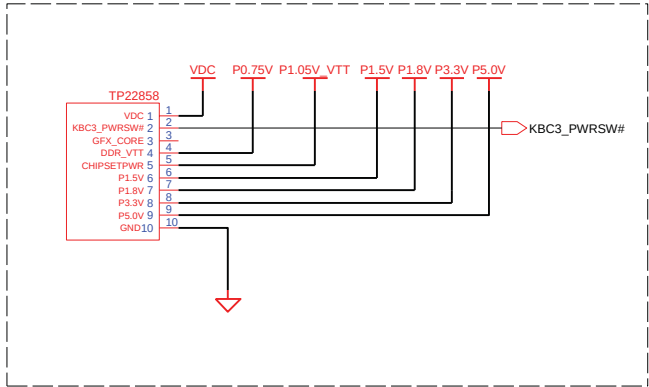
Power Button



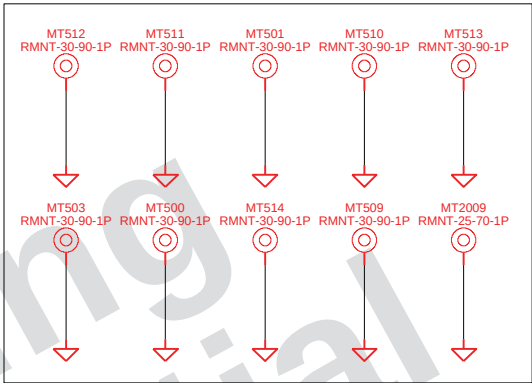
USB sub board mount hole

DESIGN	MS YANG	DATE	8/11/2009	TITLE	BREMEN-M SUB BOARD1	SAMSUNG ELECTRONICS
CHECK	SE LEE	DEV. STEP	PV			
APPROVAL	MK KIM	REV	REV 0.9		2 USB & POWER SW	PART NO. BA41-01174A
MODULE CODE		LAST EDIT				
				October 20, 2009 21:30:55 PM	PAGE	54 OF 56

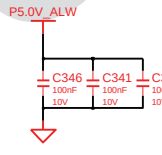
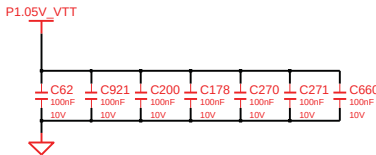
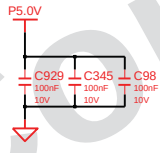
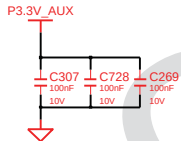
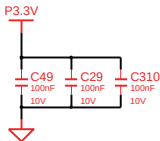
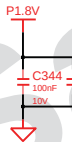
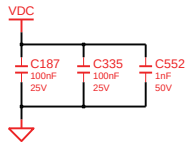
ICT PORT



Mainboard Mount ((30,80)x9), ((30,90)x9), ((25,70)x1))



Top : (30,80) x 9
Bot : (30,90) x 9



DRAW	MS YANG	DATE	8/11/2009	TITLE	BREMEN-M	SAMSUNG
CHECK	SE LEE	DEV. STEP	PV	ICT PORT	ICT PORT	ELECTRONICS
APPROVAL	MK KIM	REV	REV 0.9	ICT PORT	ICT PORT	PART NO.
MODULE CODE	LAST EDIT					BA41-01174A
				October 20, 2009 21:30:55 PM	PAGE	56 OF 56